



Focus Product Selector Guide

Microcontrollers • Digital Signal Controllers • Analog • Memory • Wireless

A circular collage of five images arranged in a pentagonal shape, each representing a different aspect of Microchip's support ecosystem:

- Design:** A person wearing blue gloves holding a silicon wafer.
- Training:** A man writing on a whiteboard.
- Resources:** A screenshot of the Microchip Product Selector Guide website.
- Development:** A circuit board, a USB device, and a CD labeled "MLAB IDE".
- Support:** A woman wearing a headset smiling.
- Availability:** A globe with connection points.

The collage is set against a dark blue background with light blue curved lines.

Microchip: A Partner in Your Success

Microchip is a leading provider of microcontroller and analog semiconductors, providing low-risk product development, lower total system cost and faster time to market for thousands of diverse customer applications worldwide. Offering outstanding technical support along with dependable delivery and quality, Microchip serves over 70,000 customers in more than 65 countries who are designing high-volume embedded control applications in the consumer, automotive, office automation, communications and industrial control markets worldwide.

8-bit PIC® Microcontrollers

Based on a powerful RISC core, the PIC microcontroller architecture provides users with an easy migration path from 6 to 100 pins among all families, with little or no code change required. Advanced features include sophisticated timing peripherals, integrated analog-to-digital converters and communications peripherals (Ethernet/I²C™/SPI/USB/CAN ports, LIN USARTs, op amp and digital-to-analog converters). For more information visit: www.microchip.com/8bit.

16-bit PIC Microcontrollers

The 16-bit PIC24 Family is comprised of two sub-families. The PIC24F offers a cost-effective low-power step up in performance, memory and peripherals for many applications that are pushing the envelope of 8-bit microcontroller capabilities. For more demanding applications, the PIC24H/E offers up to 70 MIPS performance, up to 150°C operation, more memory and additional peripherals, such as CAN communication modules. For more information visit: www.microchip.com/16bit.

dsPIC® Digital Signal Controllers

The dsPIC family of Digital Signal Controllers (DSCs) features a fully implemented digital signal processor (DSP) engine, with up to 70 MIPS performance, C compiler friendly design and a familiar microcontroller architecture and design environment. The dsPIC 16-bit Flash DSCs provide the industry's highest performance, and have features supporting motor control, digital power conversion, speech and audio, intelligent sensing and general purpose embedded control applications. For more information visit: www.microchip.com/dspic.

32-bit PIC Microcontrollers

The PIC32 family adds more performance and more memory while maintaining pin, peripheral and software compatibility with Microchip's 16-bit MCU/DSC families. The PIC32 family operates at up to 105 DMIPS and offers ample code and data space capabilities with up to 512 KB Flash and 128 KB RAM. For more information visit: www.microchip.com/32bit.

Analog and Interface Products

Microchip's integrated analog technology, peripherals and features are engineered to meet today's demanding design requirements. Our broad spectrum of analog products addresses thermal management, power management, battery management, mixed-signal, linear, interface and safety and security solutions. Our broad portfolio of stand-alone analog and interface devices offers highly integrated solutions that combine various analog functions in space-saving packages and support a variety of bus interfaces. Many of these devices support functionality that enhances the analog features currently available on PIC microcontrollers. For more information visit: www.microchip.com/analog.

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RF Front End Products

Microchip's selection of RF front end devices enhance the performance and operating range of wireless products at 2.4 and 5 GHz. SST Power amplifier products provide high linear output power as required for 802.11 (Wi-Fi®) and 802.15.4 (ZigBee®) standards with industry leading efficiency and reliability. Our selection of integrated Front End Modules (FEM) combines the function of power amplifier with switches, Low Noise Amplifier (LNA) and filters into a single space-saving package. The FEM reduces board complexity and sizes. For more information visit: www.microchip.com/analog.

Wireless Products

Microchip offers radio-frequency products for adding wireless connectivity to embedded PIC microcontroller and dsPIC DSC-based designs for the following technologies: IEEE 802.15.4/ZigBee, Sub-GHz RF, Bluetooth® and IEEE 802.11/Wi-Fi. For more information visit: www.microchip.com/wireless.

Memory Products

Microchip's broad portfolio of memory devices include Serial EEPROM, Serial SRAM, Serial Flash and Parallel Flash Devices. Our innovative, low-power designs and extensive testing have ensured industry leading robustness and endurance along with best-in-class quality at low costs. For more information visit: www.microchip.com/memory.

Real-Time Clocks

Microchip offers a family of highly integrated, low cost Real-Time Clock/Calendar devices with battery backup capability, digital trimming along with onboard EEPROM and SRAM memory. For more information visit: www.microchip.com/clock.

MOST®

Media Oriented Systems Transport (MOST) is the accepted standard in high-bandwidth automotive infotainment systems. MOST is broadly standardized from the physical layer up to the application level. Various speed grades and physical layers are available. MOST carries A/V streaming, packet, isochronous and control data, has a high flexibility and scalability and is approved to carry DVD and Blu-ray™ content using Digital Transmission Content Protection (DTCP). For more information visit: www.microchip.com/automotivesmsc.

PC System & I/O Controllers

Microchip offers a full line of mobile PC solutions including embedded controllers, keyboard controllers (KBC), mobile I/O controllers and docking products. For more information visit: www.microchip.com/pcsystemscontrollerssmsc.

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8-BIT PIC® MICROCONTROLLERS

Product	Released (R) Not Released (NR)		Memory	Operating Speed	LCD Segments	mTouch™ Channels	Analog Sensing & Measurement						Digital			Communication		Monitors		Special Features			
	Pins						Program		Self-Read/Write		Data RAM (B)		Data EE (B)		Voltage Range		Maximum Speed		Internal Oscillator				
	Total	I/O	Core																				
40/44-Pin (Cont.)	PIC18F45J10	R	40	32	PIC18	32 KB 16 Kw	RW	1024	-	2V-3.6V	40 MHz	31 kHz	-	13	-	13	-	2	-	-	-	\$1.81	PDIP (P), TQFP (PT), QFN (ML)
	PIC18F46K20	R	40	36	PIC18	64 KB 32 Kw	RW	3936	1024	1.8V-3.6V	64 MHz	16 MHz, 31 kHz	-	14	-	14	-	2	-	-	-	\$1.82	PDIP (P), TQFP (PT), 8x8 QFN (ML)
	PIC18F45K22	R	40	36	PIC18	32 KB 16 Kw	RW	1536	256	1.8V-5.5V	64 MHz	16 MHz, 31 kHz	-	28	-	28	-	2	✓	-	-	\$1.89	PDIP (P), TQFP (PT), 8x8 QFN (ML), 5x5 UQFN (MV)
	PIC18F44J11	R	40	34	PIC18	16 KB 8 Kw	RW	3800	-	2V-3.6V	48 MHz	8 MHz, 31 kHz	-	13	-	13	-	2	✓	-	-	\$1.95	TQFP (PT), QFN (ML)
	PIC18F45K50	R	40	36	PIC18	32KB 16 KW	RW	2K	256	1.8V-5.5V	48 MHz	48 MHz	-	25	-	25	-	2	✓	-	-	\$1.99	PDIP (P), TQFP (PT), 5x5 UQFN (MV)
	PIC18F45J11	R	40	34	PIC18	32 KB 16 Kw	RW	3800	-	2V-3.6V	48 MHz	8 MHz, 31 kHz	-	13	-	13	-	2	✓	-	-	\$2.09	TQFP (PT), QFN (ML)
	PIC18F44J50	R	40	34	PIC18	16 KB 8 Kw	RW	3800	-	2V-3.6V	48 MHz	8 MHz, 31 kHz	-	13	-	13	-	2	✓	-	-	\$2.16	TQFP (PT), QFN (ML)
	PIC18F45K80	R	40	35	PIC18	32 KB 16 Kw	RW	3648	1024	1.8V-5.5V	64 MHz	8 MHz, 31 kHz	-	11	-	11	2	✓	-	-	-	\$2.17	PDIP (P), TQFP (PT), QFN (ML)
	PIC18F46K22	R	40	36	PIC18	64 KB 32 Kw	RW	3896	1024	1.8V-5.5V	64 MHz	16 MHz, 31 kHz	-	28	-	28	-	2	✓	-	-	\$2.17	PDIP (P), TQFP (PT), 8x8 QFN (ML), 5x5 UQFN (MV)
	PIC18F45J50	R	40	34	PIC18	32 KB 16 Kw	RW	3800	-	2V-3.6V	48 MHz	8 MHz, 31 kHz	-	13	-	13	-	2	✓	-	-	\$2.30	TQFP (PT), QFN (ML)
	PIC18F46J11	R	40	34	PIC18	64 KB 32 Kw	RW	3800	-	2V-3.6V	48 MHz	8 MHz, 31 kHz	-	13	-	13	-	2	✓	-	-	\$2.37	PDIP (P), TQFP (PT), QFN (ML)
	PIC18F46K80	R	44	35	PIC18	64 KB 32 Kw	RW	3648	1024	1.8V-5.5V	64 MHz	8 MHz, 31 kHz	-	11	-	11	2	✓	-	-	-	\$2.45	PDIP (P), TQFP (PT), QFN (ML)
	PIC18F46J13	R	44	34	PIC18	64 KB 32 Kw	RW	3808	-	2V-3.6V	48 MHz	8 MHz, 31 kHz	-	13	-	13	3	✓	-	-	-	\$2.52	TQFP (PT), QFN (ML)
	PIC18F46J53	R	44	33	PIC18	64 KB 32 Kw	RW	3808	-	2V-3.6V	48 MHz	8 MHz, 31 kHz	-	13	-	13	3	✓	-	-	-	\$2.73	TQFP (PT), QFN (ML)
	PIC18F47J13	R	44	34	PIC18	128 KB 64 Kw	RW	3808	-	2V-3.6V	48 MHz	8 MHz, 31 kHz	-	13	-	13	3	✓	-	-	-	\$2.76	TQFP (PT), QFN (ML)
	PIC18F47J53	R	44	33	PIC18	128 KB 64 Kw	RW	3808	-	2V-3.6V	48 MHz	8 MHz, 31 kHz	-	13	-	13	3	✓	-	-	-	\$2.97	TQFP (PT), QFN (ML)
64-Pin	PIC16F1526	R	64	54	EMR	14 KB 8 Kw	RW	768	-	1.8V-5.5V	20 MHz	16 MHz	-	30	-	30	-	-	-	-	-	\$1.47	TQFP (PT), QFN (MR)
	PIC16F1527	R	64	54	EMR	28 KB 16 Kw	RW	1536	-	1.8V-5.5V	20 MHz	16 MHz	-	30	-	30	-	-	-	-	-	\$1.54	TQFP (PT), QFN (MR)
	PIC16F1946	R	64	53	EMR	14 KB 8 Kw	RW	512	256	1.8V-5.5V	32 MHz	32 MHz, 31 kHz	184	17	-	17	-	3	-	-	-	\$1.75	TQFP (PT), QFN (MR)
	PIC16F1947	R	64	53	EMR	28 KB 16 Kw	RW	1024	256	1.8V-5.5V	32 MHz	32 MHz, 31 kHz	184	17	-	17	-	3	-	-	-	\$1.82	TQFP (PT), QFN (MR)
	PIC18F63J11	R	64	54	PIC18	8 KB 4 Kw	RW	1024	-	2V-3.6V	40 MHz	8 MHz, 31 kHz	-	12	-	12	-	2	-	-	-	\$2.20	TQFP (PT)
	PIC18F65J10	R	64	50	PIC18	32 KB 16 Kw	RW	2048	-	2V-3.6V	40 MHz	8 MHz, 31 kHz	-	11	-	11	-	2	-	-	-	\$2.25	TQFP (PT)
	PIC18F64J11	R	64	54	PIC18	16 KB 8 Kw	RW	1024	-	2V-3.6V	40 MHz	8 MHz, 31 kHz	-	12	-	12	-	2	-	-	-	\$2.27	TQFP (PT)
	PIC18F63J90	R	64	51	PIC18	8 KB 4 Kw	RW	1024	-	2V-3.6V	40 MHz	8 MHz, 31 kHz	132	12	-	12	-	2	-	-	-	\$2.35	TQFP (PT)

Products sorted by pin count followed by pricing.

† Pricing subject to change; please contact your Microchip representative for most current pricing.

◊ Software PLVD implemented via ADC.

* Integrated Temperature Indicator: Reference Application Note AN1333 for implementation.

‡ eXtreme Low Power variants available.

dsPIC33 DSC SMPS AND DIGITAL POWER CONVERSION FAMILY

Product		Released (R) Not Released (NR)	I/O Pins	Core	Memory			Voltage Range	Operating Speed	Analog			Communication			Monitors	System Mgmt. Features	Packages (Designator)									
					Program (KB)	Data RAM (B)	EEPROM			Maximum Speed MIPS	Internal Oscillator	ADC 10-bit 2000 kps (\pm 4000 kps)	DAC	Comparators	Output Compare/PWM	Input Capture	Power Supply PWM Ch ⁽¹⁾										
18-Pin	dsPIC33FJ06GS001	R	13	dsPIC®	6	256	AN1095 ⁽¹⁾	-	3V–3.6V	40	7.37 MHz, 32 kHz	6 ch	2 × 10-bit	2	-	-	4	-	2	1 UART, 1 SPI, 1 I ² C™	-	-	-	-	\$1.61	BOR, POR, WDT	PDIP (P), SOIC (SO), SSOP (SS)
	dsPIC33FJ06GS101A	R	13	dsPIC	6	256	AN1095 ⁽¹⁾	-	3V–3.6V	40	7.37 MHz, 32 kHz	6 ch	-	-	1	-	4	-	2	1 UART, 1 SPI, 1 I ² C	-	-	-	-	\$1.75	BOR, POR, WDT	PDIP (P), SOIC (SO), SSOP (SS)
28-Pin	dsPIC33FJ06GS102A	R	21	dsPIC	6	256	AN1095 ⁽¹⁾	-	3V–3.6V	40	7.37 MHz, 32 kHz	6 ch	-	-	1	-	4	-	2	1 UART, 1 SPI, 1 I ² C	-	-	-	-	\$1.95	BOR, POR, WDT	SDIP (SP), SOIC (SO), SSOP (SS), QFN (MM)
	dsPIC33FJ06GS202A	R	21	dsPIC	6	1024	AN1095 ⁽¹⁾	-	3V–3.6V	40	7.37 MHz, 32 kHz	6 ch	2 × 10-bit	2	1	1	4	-	2	1 UART, 1 SPI, 1 I ² C	-	-	-	-	\$2.06	BOR, POR, WDT	SDIP (SP), SOIC (SO), SSOP (SS), QFN (MM)
	dsPIC33FJ09GS302	R	21	dsPIC	9	1024	AN1095 ⁽¹⁾	-	3V–3.6V	40	7.37 MHz, 32 kHz	8 ch	2 × 10-bit	2	1	1	6	-	2	1 UART, 1 SPI, 1 I ² C	-	-	-	-	\$2.17	BOR, POR, WDT	SDIP (SP), SOIC (SO), SSOP (SS), QFN (MM)
	dsPIC33FJ16GS402*	R	21	dsPIC	16	2048	AN1095 ⁽¹⁾	-	3V–3.6V	50	7.37 MHz, 32 kHz	8 ch	-	-	2	2	6	-	3	1 UART, 1 SPI, 1 I ² C	-	-	-	-	\$2.52	BOR, POR, WDT	SPDIP (SP), SOIC (SO), QFN (MM)
	dsPIC33FJ16GS502*	R	21	dsPIC	16	2048	AN1095 ⁽¹⁾	-	3V–3.6V	50	7.37 MHz, 32 kHz	8 ch, 2 ADC†	4 × 10-bit	4	2	2	8	-	3	1 UART, 1 SPI, 1 I ² C	-	-	-	-	\$3.04	BOR, POR, WDT	SPDIP (SP), SOIC (SO), QFN (MM)
44-Pin	dsPIC33FJ16GS404*	R	35	dsPIC	16	2048	AN1095 ⁽¹⁾	-	3V–3.6V	50	7.37 MHz, 32 kHz	8 ch	-	-	2	2	6	-	3	1 UART, 1 SPI, 1 I ² C	-	-	-	-	\$2.77	BOR, POR, WDT	TQFP (PT), QFN (ML)
	dsPIC33FJ16GS504*	R	35	dsPIC	16	2048	AN1095 ⁽¹⁾	-	3V–3.6V	50	7.37 MHz, 32 kHz	12 ch, 2 ADC†	4 × 10-bit	4	2	2	8	-	3	1 UART, 1 SPI, 1 I ² C	-	-	-	-	\$3.42	BOR, POR, WDT	TQFP (PT), QFN (ML)
64-Pin	dsPIC33FJ32GS406	R	58	dsPIC	32	4096	AN1095 ⁽¹⁾	-	3V–3.6V	50	7.37 MHz, 32 kHz	16 ch	-	-	4	4	12	1	5	2 UART, 2 SPI, 2 I ² C	-	-	-	-	\$3.07	BOR, POR, WDT	TQFP (PT), QFN (MR)
	dsPIC33FJ64GS406	R	58	dsPIC	64	8192	AN1095 ⁽¹⁾	-	3V–3.6V	50	7.37 MHz, 32 kHz	16 ch	-	-	4	4	12	1	5	2 UART, 2 SPI, 2 I ² C	-	-	-	-	\$3.35	BOR, POR, WDT	TQFP (PT), QFN (MR)
	dsPIC33FJ32GS606	R	58	dsPIC	32	4096	AN1095 ⁽¹⁾	-	3V–3.6V	50	7.37 MHz, 32 kHz	16 ch, 2 ADC†	4 × 10-bit	4	4	4	12	2	5	2 UART, 2 SPI, 2 I ² C	-	-	-	-	\$3.36	BOR, POR, WDT	TQFP (PT), QFN (MR)
	dsPIC33FJ64GS606	R	58	dsPIC	64	9216	AN1095 ⁽¹⁾	4	3V–3.6V	50	7.37 MHz, 32 kHz	16 ch, 2 ADC†	4 × 10-bit	4	4	4	12	2	5	2 UART, 2 SPI, 2 I ² C	1	-	-	-	\$3.81	BOR, POR, WDT	TQFP (PT), QFN (MR)
80-Pin	dsPIC33FJ32GS608	R	74	dsPIC	32	4096	AN1095 ⁽¹⁾	-	3V–3.6V	50	7.37 MHz, 32 kHz	18 ch, 2 ADC†	4 × 10-bit	4	4	4	16	2	5	2 UART, 2 SPI, 2 I ² C	-	-	-	-	\$3.85	BOR, POR, WDT	TQFP (PT)
	dsPIC33FJ64GS608	R	74	dsPIC	64	9216	AN1095 ⁽¹⁾	4	3V–3.6V	50	7.37 MHz, 32 kHz	18 ch, 2 ADC†	4 × 10-bit	4	4	4	16	2	5	2 UART, 2 SPI, 2 I ² C	1	-	-	-	\$4.34	BOR, POR, WDT	TQFP (PT)
100-Pin	dsPIC33FJ32GS610	R	85	dsPIC	32	4096	AN1095 ⁽¹⁾	-	3V–3.6V	50	7.37 MHz, 32 kHz	24 ch, 2 ADC†	4 × 10-bit	4	4	4	18	2	5	2 UART, 2 SPI, 2 I ² C	-	-	-	-	\$4.41	BOR, POR, WDT	TQFP (PF, PT)
	dsPIC33FJ64GS610	R	85	dsPIC	64	9216	AN1095 ⁽¹⁾	4	3V–3.6V	50	7.37 MHz, 32 kHz	24 ch, 2 ADC†	4 × 10-bit	4	4	4	18	2	5	2 UART, 2 SPI, 2 I ² C	1	-	-	-	\$4.89	BOR, POR, WDT	TQFP (PF, PT)

* Parts available with High Temperature Options (150°C).

† 4 Msps devices with 2 ADCs

Note 1: See Application Note "AN1095: Emulating Data EEPROM".

2: Two 16-bit timers can be concatenated to form a 32-bit timer.

POWER MANAGEMENT: Power MOSFETs

Product	V _{Ds} (V)	Configuration	Polarity	R _{DS(on)} @ 4.5V (mΩ, Max.)	R _{DS(on)} @ 10V (mΩ, Max.)	Q _G @ 4.5V (nC, Max.)	I _D (A, Max. @ 25°C, T _{CASE})	V _{GS(th)} (V, Min.)	Q _{GD} (nC, Typ.)	R _G (Ω Typ.)	Package
MCP87018	25	Single	N-Channel	2.2	1.9	37	100	1	13	1.5	5 x 6 PDFN
MCP87022	25	Single	N-Channel	2.6	2.3	29	100	1	9	1.3	5 x 6 PDFN
MCP87030	25	Single	N-Channel	4	3.5	22	100	1	6.7	1.2	5 x 6 PDFN
MCP87050	25	Single	N-Channel	6	5	15	100	1	4.7	1.1	5 x 6 PDFN
MCP87055	25	Single	N-Channel	7	6	14	60	1	4.5	2.1	3.3 x 3.3 PDFN
MCP87090	25	Single	N-Channel	12	10.5	10	64	1.1	2.8	1.8	5 x 6 PDFN, 3.3 x 3.3 PDFN
MCP87130	25	Single	N-Channel	16.5	13.5	8	54	1.1	2.6	1.7	5 x 6 PDFN, 3.3 x 3.3 PDFN

POWER MANAGEMENT: Linear Regulators

Product	Max. Input Voltage (V)	Output Voltage (V)	Output Current (mA)	Typical Active Current (µA)	Typical Dropout Voltage @ Max. I _{out} (mV)	Typical Output Voltage Accuracy (%)	Features	Packages
TC1016/17	6	1.8 to 4.0	80/150	53	150/285	±0.5	Shutdown	SOT-23A, SC70
TC1301A/B	6	1.5 to 3.3	LD01: 300 LD02: 150	103/114	LD01: 104 LD02: 150	±0.5	Dual LDO plus Reset output, Shutdown, Reference bypass, Voltage detect	MSOP, DFN
TC1302AB	6	1.5 to 3.3	LD01: 300 LD02: 150	103/114	LD01: 104 LD02: 150	±0.5	Dual LDO, Shutdown, Reference bypass, Voltage detect	MSOP, DFN
TC2014/5, TC2185	6	1.8 to 5.0	50/100/150	55	45/90/140	±0.4	Shutdown, Reference bypass input	SOT-23A
TC2054/5, TC2186	6	1.8 to 5.0	50/100/150	55	45/90/140	±0.4	Shutdown, Error output	SOT-23A
MCP1700	6	1.2 to 5.0	250	1.6	300	±0.4	Very low I _Q	SOT-23A, SOT-89, TO-92
MCP1702/3 / 3A	13.2/16/16	1.2 to 5.0	250	2	330/625/625	±0.4	Very low I _Q	DFN, TO-92, SOT-23A, SOT-89, SOT-223
MCP1725/6/7	6	0.8 to 5.0	500/1000/1500	120/140/140	210/300/330	±0.5	Shutdown, C _{DELAY} , Power Good	SOIC, DFN
MCP1754/S	16	1.8 to 5.5	150	56	300	±0.4	Power Good, Shutdown	DFN, SOT-23A, SOT-89, SOT-223
MCP1755/S	16	1.8 to 5.5	300	68	300	±2.0	Shutdown, High PSRR	DFN, SOT-23, SOT-223
MCP1790/1	30	3.0, 3.3, 5.0	70	70	500	±0.2	Load dump, Shutdown, Power Good	SOT-223, DDPAK
MCP1804	28	1.8 to 18	150	50	300	±0.5	Shutdown, High PSRR	SOT-23, SOT-89, SOT-223
MCP1824/5/6/7	6	0.8 to 5.0	300/500/1000/1500	120/120/140/140	200/210/300/330	±0.5	Fixed and Adjustable output, Shutdown, Power Good	SOT-23, SOT-223, TO-220, DDPAK
MCP1824S/5S/6S/7S	6	0.8 to 5.0	300/500/1000/1500	120/120/140/140	200/210/300/330	±0.5	3-pin high current LDOs	SOT-223, TO-220, DDPAK

POWER MANAGEMENT: Charge Pump DC-to-DC Converters

Product	Input Voltage Range (V)	Output Voltage (V)	Operating Temp. Range (°C)	Max. Input Current (µA)	Typical Output Current (mA)	Features	Packages
TC1044S	1.5 to 12	-V _{IN} or 2*V _{IN}	-40 to +85	160	20	85 kHz oscillator Boost mode	PDIP, SOIC
TC7660	1.5 to 10	-V _{IN} or 2*V _{IN}	-40 to +85	180	20	10 kHz oscillator	PDIP, SOIC
TC7660H	1.5 to 10	-V _{IN} or 2*V _{IN}	-40 to +85	1000	20	120 kHz oscillator	PDIP, SOIC
TC7660S	1.5 to 12	-V _{IN} or 2*V _{IN}	-40 to +85	160	20	45 kHz oscillator Boost mode	PDIP, SOIC
TC7662B	1.5 to 15	-V _{IN} or 2*V _{IN}	-40 to +85	180	20	35 kHz oscillator Boost mode	PDIP, SOIC
TC7662A	3.0 to 18	-V _{IN} or 2*V _{IN}	-40 to +85	200	40	12 kHz oscillator	PDIP, SOIC
MCP1256	1.8 to 3.6	3.3	-40 to +85	100	100	Power Good Sleep mode	MSOP, DFN
MCP1257	1.8 to 3.6	3.3	-40 to +85	100	100	Sleep mode low battery indication	MSOP, DFN
MCP1258	1.8 to 3.6	3.3	-40 to +85	100	100	Low battery indication input/output bypass 1	MSOP, DFN

POWER MANAGEMENT: CPU/System Supervisors

Product	Description	Operating Temp. Range (°C)	Features	Packages
MCP11(1/2) TC (1/2/3/4)	System Voltage Detectors (No Reset Delay)	-40 to +125 -40 to +85	Wide V _{CC} input range, Wide detection range (custom options available), Low current, CMOS/Push-Pull active low reset options	5-pin SOT-23, 3-pin TO-92, 3-pin SOT-23A, 3-pin SOT-89, 3-pin SC70
MCP809, MCP100, MCP130, MCP120 MCP13XX, TC1270A and more	System Voltage Supervisors (Available Reset Delays)	-40 to +125 -40 to +85	Wide detection range (custom options available), Low current, Push-Pull/Open Drain, Active high/low, Watchdog, Manual reset, Dual output options, Multiple reset delay options	8-pin SOIC (150 mil), 5-pin SOT-23, 4-pin SOT-143, 3-pin TO-92, 3-pin SOT-23, 5-pin SC70

POWER MANAGEMENT: Power MOSFET Drivers							
Product	Configuration	Operating Temp. Range (°C)	Peak Output Current (A)	Output Resistance (Max. @ 25 °C)	Max Supply Voltage (V)	Input/Output Delay (ns)	Packages
MCP1401/02 Single	Inverting/Non-inverting	-40 to +125	0.5	18/16	18	40/40	SOT-23
MCP1415/16 Single	Inverting/Non-inverting	-40 to +125	1.5	7.5/5.5	18	50/55	SOT-23
TC4467/8/9 Quad	Inverting/ Non-inverting	-40 to +85	1.2	15/15	18	40/40	PDIP, SOIC
TC4426A/27A/28A Dual	Inverting/Non-inverting	-40 to +125	1.5	9/9	18	30/30	PDIP, SOIC, DFN
TC4423A/24A/25A Dual	Inverting/Non-inverting	-40 to +125	3	3 (typ.)/4 (typ.)	18	40 (typ.)/40 (typ.)	PDIP, SOIC, DFN
MCP14E3/E4/E5 Dual	Inverting/Non-inverting	-40 to +125	4	3.5/3.0	18	55/55	PDIP, SOIC, DFN
MCP14E6/E7/E8 Dual	Inverting/Non-inverting/Inverting and Non-inverting	-40 to +125	2	2.2/2.8	18	45/45	PDIP, SOIC, DFN
MCP14E9/E10/E11 Dual	Inverting/Non-inverting/Inverting and Non-inverting	-40 to +125	3	2.2/2.8	18	75/75	PDIP, SOIC, DFN
MCP1406/07 Single	Inverting/Non-inverting	-40 to +125	6	1.8/2.0 (typ.)	18	30/30	TO-220, PDIP, SOIC, DFN
TC4420/29	Inverting/Non-inverting	-40 to +125	6	2.8/2.5	18	55/55	TO-220, PDIP, SOIC, DFN
TC4421A/22A Single	Inverting/ Non-inverting	-40 to +125	9	1.25 (typ.)/1.5	18	38/42	TO-220, PDIP, SOIC, DFN
TC4451/52 Single	Inverting/ Non-inverting	-40 to +125	12	0.6 (typ.)/1.5	18	15/15	TO-220, PDIP, SOIC, DFN, DDPAK
TC4431/32 Single	Inverting/ Non-inverting	-40 to +85	1.5	10/10	30	62/78	PDIP, SOIC

POWER MANAGEMENT: Synchronous Buck High-Side Driver							
Product	Configuration	Operating Temp Range (°C)	Peak Output Current (A)	Output Resistance (Max. @ 25 °C)	Max Supply Voltage (V)	Input/Output Delay (ns)	Packages
MCP14700/14628	Dual input/Single input	-40 to +85	2	2.5/2.5	5 (V _{DD}), 36 (Boot Pin)	18/20	SOIC, DFN

POWER MANAGEMENT: Battery Chargers										
Product	Mode	Cell Type	# of Cells	V _{CC} Range (V)	Cell Voltage (V)	Max. Charging Current (mA)	Max. Voltage Regulation (%)	Int/Ext FET	Features	Packages
MCP73113/14/23	Linear	Li-ion/Li-Polymer and LiFePO4	1	4 to 16	3.6, 4.1, 4.2, 4.35, 4.4	1100	±0.5	Int	6.5/5.8V Overvoltage protection, UVLO, Thermal regulation	10-pin 3 x 3 DFN
MCP73213/23	Linear	Li-ion/Li-Polymer and LiFePO4	2	4 to 16	7.2, 8.2, 8.4, 8.7, 8.8	1100	±0.6	Int	13V Overvoltage protection	10-pin 3 x 3 DFN
MCP73830/L	Linear	Li-ion/Li-Polymer	1	3.75 to 6	4.2	1000/200	±0.75	Int	Soft-start, Charge enable pin	6-pin 2 x 2 TDFN
MCP73831/2	Linear	Li-ion/Li-Polymer	1	3.7 to 6.0	4.2, 4.35, 4.4, 4.5	500	±0.75	Int	UVLO, Thermal regulation, Programmable charge current, Tri-state or open-drain STAT pin	8-pin 2 x 3 DFN, 5-pin SOT-23
MCP73837/8	Linear	Li-ion/Li-Polymer	1	3.7 to 6.0	4.2, 4.35, 4.4, 4.5	1000	±0.75	Int	Dual input (USB/DC) auto-switching, Thermistor input, Power Good output or Timer enable input	10-pin MSOP, 10-pin 3 x 3 DFN
MCP73871	Linear	Li-ion/Li-Polymer	1	3.75 to 6.0	4.1, 4.2, 4.35, 4.4	1500 (A/C Adapter) 500 (USB)	±0.5	Int	Simultaneous charging of load and battery, Load-dependent charging, Multiple programmable charge currents	20-pin 4 x 4 QFN

LINEAR: Op Amps													
Product	# per Package	GBWP (MHz)	I _Q Typical (µA)	V _{OS} Max (mV)	Operating Voltage (V)	Packages	Product	# per Package	GBWP (MHz)	I _Q Typical (µA)	V _{OS} Max (mV)	Operating Voltage (V)	Packages
MCP661/2/3/4/5/9	1/2/1/4/2/4	60	6000	8	2.5 to 5.5	SOIC, MSOP, DFN, TSSOP, QFN, SOT	MCP6V26/7/8	1/2/1	2	620	0.002	2.3 to 5.5	SOIC, MSOP, DFN
MCP651/1S/2/3/4/5/9	1/1/2/1/4/2/4	50	6000	0.2	2.5 to 5.5	SOIC, MSOP, DFN, TSSOP, QFN, SOT	MCP6071/2/4	1/2/4	1.2	110	0.15	1.8 to 6.0	SOIC, TSSOP, DFN, SOT
MCP631/2/3/4/5/9	1/2/1/4/2/4	24	2500	8	2.5 to 5.5	SOIC, MSOP, DFN, TSSOP, QFN, SOT	MCP6H01/2/4	1/2/4	1.2	135	4.5	3.5 to 16	SOIC, TSSOP, TDFN, SOT, SC70
MCP621/1S/2/3/4/5/9	1/1/2/1/4/2/4	20	2500	0.2	2.5 to 5.5	SOIC, MSOP, DFN, TSSOP, QFN, SOT	MCP6001/2/4	1/2/4	1	100	4.5	1.8 to 6.0	PDIP, SOIC, MSOP, TSSOP, TDFN, SOT, SC70
MCP6H91/2/4	1/2/4	10	2000	4	3.5 to 12.0	DFN, SOIC, TSSOP	MCP6401/2/4	1/2/4	1	45	4.5	1.8 to 6.0	SOIC, TSSOP, TDFN, SOT, SC70
MCP6021/2/3/4	1/2/1/4	10	1000	0.5	2.5 to 5.5	PDIP, SOIC, MSOP, TSSOP, SOT	MCP6061/2/4	1/2/4	0.73	60	0.15	1.8 to 6.0	SOIC, TSSOP, DFN, SOT
MCP6291/2/3/4/5	1/2/1/4/2	10	1000	3	2.4 to 6.0	PDIP, SOIC, MSOP, TSSOP, SOT	MCP6241/2/4	1/2/4	0.55	50	5	1.8 to 5.5	PDIP, SOIC, MSOP, TSSOP, TDFN, SOT, SC70
MCP6491/2/4	1/2/4	7.5	530	1.5	2.4 to 5.5	SOT, SC70, MSOP, TDFN, SOIC, TSSOP	MCP6051/2/4	1/2/4	0.385	30	0.15	1.8 to 6.0	SOIC, TSSOP, DFN, SOT
MCP6H81/2/4	1/2/4	5.5	700	4	3.5 to 12.0	DFN, SOIC, TSSOP	MCP6V31	1	0.3	23	0.008	1.8 to 5.5	SOT, SC70
MCP6281/2/3/4/5	1/2/1/4/2	5	445	3	2.2 to 6.0	PDIP, SOIC, MSOP, TSSOP, SOT	MCP6231/2/4	1/2/4	0.3	20	5	1.8 to 6.0	PDIP, SOIC, MSOP, TSSOP, TDFN, SOT, SC70
MCP6481/2/4	1/2/4	4	240	1.5	2.2 to 5.5	SOT, SC70, MSOP, TDFN, SOIC, TSSOP	MCP616/7/8/9	1/2/1/4	0.19	19	0.15	2.3 to 5.5	PDIP, SOIC, MSOP, TSSOP
MCP6286	1	3.5	540	1.5	2.2 to 5.5	SOT	MCP606/7/8/9	1/2/1/4	0.155	19	0.25	2.5 to 6.0	PDIP, SOIC, TSSOP, SOT
MCP601/2/3/4	1/2/1/4	2.8	230	2	2.7 to 6.0	PDIP, SOIC, TSSOP, SOT	MCP6141/2/3/4	1/2/1/4	0.1	0.6	3	1.4 to 6.0	PDIP, SOIC, MSOP, TSSOP, SOT
MCP6H71/2/4	1/2/4	2.7	480	4	3.5 to 12.0	DFN, SOIC, TSSOP	MCP6421	1	0.09	4.4	1	1.8 to 5.5	SOT, SC70
MCP6271/2/3/4/5	1/2/1/4/2	2	170	3	2.0 to 6.0	PDIP, SOIC, MSOP, TSSOP, SOT	MCP6V11	1	0.08	7.5	0.008	1.6 to 5.5	SOT, SC70
MCP6471/2/4	1/2/4	2	100	1.5	2 to 5.5	SOT, SC70, MSOP, TDFN, SOIC, TSSOP	MCP6041/2/3/4	1/2/1/4	0.014	0.6	3	1.4 to 6.0	PDIP, SOIC, MSOP, TSSOP, SOT
MCP6V01/2/3	1/2/1	1.3	300	0.002	1.8 to 5.5	SOIC, DFN, TDFN	MCP6031/2/3/4	1/2/1/4	0.01	0.9	0.15	1.8 to 5.5	SOIC, MSOP, TSSOP, DFN, SOT
MCP6V06/7/8	1/2/1	1.3	300	0.003	1.8 to 5.5	SOIC, DFN, TDFN	MCP6441/2/4	1/2/4	0.009	0.45	4.5	1.4 to 6.0	SOIC, MSOP, TSSOP, SOT, SC70

LINEAR: Comparators								
Product	# Per Package	Typical Propagation Delay (μs)	I _Q Typical (μA)	V _{OS} Max (mV)	Operating Voltage (V)	Temperature Range (°C)	Features	Packages
MCP6541/2/3/4	1/2/1/4	4	1	5	1.6 to 5.5	-40 to +125	Push-Pull, Rail-to-Rail Input/Output	PDIP, SOIC, MSOP, TSSOP, SOT, SC70
MCP6546/7/8/9	1/2/1/4	4	1	5	1.6 to 5.5	-40 to +125	Open-drain, 9V, Rail-to-Rail Input/Output	PDIP, SOIC, MSOP, TSSOP, SOT, SC70
MCP65R41/6	1	4	2.5	10	1.8 to 5.5	-40 to +125	Integrated V _{REF} (1.21V or 2.4V)	SOT-23
MCP6561/2/4	1/2/4	0.047	100	10	1.8 to 5.5	-40 to +125	Push-Pull, Rail-to-Rail Input/Output	SOIC, MSOP, TSSOP, SOT, SC70
MCP6566/7/9	1/2/4	0.047	100	10	1.8 to 5.5	-40 to +125	Open-Drain, Rail-to-Rail Input/Output	SOIC, MSOP, TSSOP, SOT, SC70

MIXED SIGNAL: Successive Approximation Register (SAR) Analog-to-Digital Converters

Product	Resolution (bits)	Maximum Sampling Rate (ksamples/sec)	# of Input Channels	Input Type	Interface	Max. Supply Current (μA)	Temperature Range (°C)	Packages
MCP3021/3221	10/12	22	1	Single-ended	I ² C™	250	-40 to +125	SOT-23A
MCP3001/2/4/8	10	200	1/2/4/8	Single-ended	SPI	500-550	-40 to +85	PDIP, SOIC, MSOP, TSSOP
MCP3201/2/4/8	12	100	1/2/4/8	Single-ended	SPI	400-550	-40 to +85	PDIP, SOIC, MSOP, TSSOP
MCP3301/2/4	13	100	1/2/4	Differential	SPI	450	-40 to +85	PDIP, SOIC, MSOP, TSSOP

MIXED SIGNAL: Digital-to-Analog Converters

Product	Resolution (Bits)	DAC Channels	Interface	Voltage Reference	Output Settling Time (μs)	DNL (±LSB)	Typical Operating Current (μA)	Temperature Range (°C)	Packages
MCP47DA1	6	1	I ² C™	V _{DD}	6	0.25	130	-40 to +125	SOT-23
MCP4706/16/26	8/10/12	1	I ² C	Ext	6	0.05/0.188/0.75	210	-40 to +125	SOT-23
MCP4725	12	1	I ² C	V _{DD}	6	0.75	175	-40 to +125	SOT-23
MCP4728	12	4	I ² C	Int	6	0.75	250	-40 to +125	MSOP
MCP4801/11/21	8/10/12	1	SPI	Int	4.5	0.5/0.5/0.75	330	-40 to +125	PDIP, SOIC, MSOP, 2x3 DFN
MCP4802/12/22	8/10/12	2	SPI	Int	4.5	0.5/0.5/0.75	415	-40 to +125	MSOP, PDIP, SOIC
MCP4901/11/21	8/10/12	1	SPI	Ext	4.5	0.5/0.5/0.75	175	-40 to +125	PDIP, SOIC, MSOP, 2x3 DFN
MCP4902/12/22	8/10/12	2	SPI	Ext	4.5	0.5/0.5/0.75	350	-40 to +125	PDIP, SOIC, TSSOP
TC1320/1	8/10	1	SMBus	Ext	10	0.8/2	350	-40 to +85	MSOP, SOIC

MIXED SIGNAL: Energy Measurement ICs

Product	Dynamic Range	Typical Accuracy	ADC Channels	ADC Resolution	SINAD	Gain Selection	Output Type	Typical Supply Current (mA)	Analog V _{DD} (V)	Digital V _{DD} (V)	Temperature Range (°C)	Packages
MCP3911	–	–	2	24-bit	94.5 dB	Up to 32	SPI	1.7	2.7 to 3.6	2.7 to 3.6	-40 to +125	SSOP, QFN
MCP3913/14	10000:1	0.1%	6/8	24-bit	94.5 dB	Up to 32	SPI	5.2/6.8	2.5 to 3.6	2.5 to 3.6	-40 to +125	SSOP, QFN
MCP3905A/06A	500:1/1000:1	0.1%	2	16-bit	–	Up to 32	Active power pulse	3.9	4.5 to 5.5	4.5 to 5.5	-40 to +125	SSOP
MCP3909	1000:1	0.1%	2	16-bit	81 dB	Up to 16	Active power pulse/SPI	3.1	4.5 to 5.5	4.5 to 5.5	-40 to +125	SSOP

MIXED SIGNAL: Current/DC Power Measurement ICs

Product	# Current Sensors	Description	Full Scale Range (mV)	Current Measurement Max. Accr. (%)	Effective Sampling Interval Min. to Max. (msec)	Bus Voltage Range (V)	# Temp. Monitors (ambient, remote)	Temp. Accuracy Typ./Max. (°C)	Alert/Therm.	Peak Detection	Interface	Packages
PAC1710	1	Current/DC Power Sensor	10, 20, 40, 80	±1	2.5 to 2600	0 to +40	N/A	N/A	1	–	SMBus/I ² C™	10-pin DFN
PAC1720	2	Dual Current/DC Power Sensor	10, 20, 40, 80	±1	2.5 to 2600	0 to +40	N/A	N/A	1	–	SMBus/I ² C	10-pin DFN
EMC1701/2/4	1	Current/DC Power Sensor with Temperature Monitoring	10, 20, 40, 80	±1	2.5 to 2600	+3 to +24	1, 0/1/3	±0.25/±1.0	2	✓	SMBus/I ² C	12-pin QFN, 10-pin MSOP, 16-pin QFN, 14-pin SOIC

MIXED SIGNAL: Digital Potentiometers										
Product	# of Taps	Memory	Channels	Interface	Resistance (kΩ)	Temperature Range (°C)	Packages			
MCP4011/12/13/14	64	Volatile	1	Up/Down	2.1, 5, 10, 50	-40 to +125	DFN, SOT-23			
MCP4017/18/19	128	Volatile	1	I ² C™	5, 10, 50, 100	-40 to +125	SC70			
MCP40D17/D18/D19	128	Volatile	1	I ² C	5, 10, 50, 100	-40 to +125	SC70			
MCP4021/22/23/24	64	Nonvolatile	1	Up/Down	2.1, 5, 10, 50	-40 to +125	DFN, SOT-23			
MCP4141/42	128	Nonvolatile	1	SPI	5, 10, 50, 100	-40 to +125	MSOP, QFN, DFN			
MCP4241/42	128	Nonvolatile	2	SPI	5, 10, 50, 100	-40 to +125	MSOP, QFN, DFN			
MCP4131/32	128	Volatile	1	SPI	5, 10, 50, 100	-40 to +125	QFN, DFN			
MCP4231/32	128	Volatile	2	SPI	5, 10, 50, 100	-40 to +125	MSOP, QFN, DFN			
MCP4151/52	256	Volatile	1	SPI	5, 10, 50, 100	-40 to +125	MSOP, QFN, DFN			
MCP4161/62	256	Nonvolatile	1	SPI	5, 10, 50, 100	-40 to +125	MSOP, QFN, DFN			
MCP4251/52	256	Volatile	2	SPI	5, 10, 50, 100	-40 to +125	MSOP, QFN, DFN			
MCP4261/62	256	Nonvolatile	2	SPI	5, 10, 50, 100	-40 to +125	MSOP, QFN, DFN			
MCP4341/42	129	Nonvolatile	4	SPI	5, 10, 50, 100	-40 to +125	TSSOP, QFN			
MCP4361/62	257	Nonvolatile	4	SPI	5, 10, 50, 100	-40 to +125	TSSOP, QFN			
MIXED SIGNAL: Delta Sigma Analog-to-Digital Converters										
Product	Resolution (bits)		Maximum Sampling Rate (samples/sec)	# of Input Channels		Interface	Typical Supply Current (µA)	Temperature Range (°C)	Features	Packages
MCP3421/2/3/4	18 to 12		4 to 240	1/2/2/4 Diff		I ² C™	155	-40 to +125	PGA, V _{REF}	SOIC, TSSOP, MSOP, DFN, SOT
MCP3425/6/7/8	16 to 12		15 to 240	1/2/2/4 Diff		I ² C	155	-40 to +125	PGA, V _{REF}	SOIC, TSSOP, MSOP, DFN, SOT
MCP3550/1/3	22		13/14/60	1 Diff		SPI	120	-40 to +125	50 & 60 Hz Rejection	SOIC, MSOP

INTERFACE: Controller Area Network (CAN), Infrared, LIN Transceivers, Ethernet, Serial Peripherals, USB Bridges									
Product	Description			Operating Temperature Range (°C)	Other Features				Packages
MCP2515	Stand-alone CAN controller with SPI Interface			-40 to +125	3 Tx Buffers, 2 Rx Buffers, 6 Filters, 2 Masks, Interrupt output, MCP2510 upgrade				PDIP, SOIC, TSSOP, QFN
MCP256(1/2)	High-Speed CAN Transceiver			-40 to +150	V _{DD} = 4.5V to 5.5V, 1 Mbps, ISO11898-5, meets automotive EMC and CAN conformance requirements, MCP2561 = SPLIT Option for common mode stabilization, MCP2562 = VIO Option for digital I/O level shifting from 1.8V to 5.5V				PDIP, SOIC, DFN
MCP200(3/4)A, MCP202(1/2)A, MCP2025, MCP2050	LIN (Local Interconnect Network) transceivers			-40 to +125	Product options: Stand-alone transceiver, integrated V _{REG} = 3.3V or 5V @ 70 mA, integrated WWDT, integrated ratio-metric battery monitor. V _{CC} Range = 6 to 18 V, Max Baud Rate = 20 Kbaud, Compliant with LIN 1.3, 2.0 2.1, SAE J2602, Automotive grade				PDIP, SOIC, TSSOP, DFN, QFN
MCP23X09/18	8-bit I/O port expander, 16-bit I/O port expander			-40 to +125	I ² C™ (up to 3.4 MHz) or SPI (up to 10 MHz) interface, 25 mA source/sink per I/O				PDIP, SDIP, SOIC, SSOP
MCP212(0/2), MCP2140A, MCP215(0/5)	Infrared IrDA encoders, Decoders, Protocol handlers			-40 to +85	UART to IR encoder/decoder w/hardware & software baud rate selection, IrDA® standard protocol handler plus encoder/decoder				PDIP, SDIP, SOIC, SSOP
MCP2200, MCP2210	USB Bridge Products: USB-to-UART, USB-to-SPI			-40 to +85	Supports full speed, USB 2.0 compliant, integrated PHY, Tx/Rx buffer size 64–128 bytes each, 8–9 GPIO, V _{DD} Range = 3.0 to 5.5V				SOIC, SSOP, QFN
ENC28J60	Stand-alone 10 Base-T Ethernet controller with SPI interface			-40 to +85	Ethernet controller, 8 KB RAM Buffer, Integrated 10Base-T PHY				SPDIP, SOIC, SSOP, QFN
ENC424J600	Stand-alone 10/100 Base-T Ethernet controller with SPI and parallel interface			-40 to +85	Ethernet controller, 24 KB RAM Buffer, Cryptographic Security Engine, 10/100Base-T PHY				TQFP, QFN
ENC624J600	Stand-alone 10/100 Base-T Ethernet controller with SPI and parallel interface			-40 to +85	Ethernet controller, 24 KB RAM Buffer, Cryptographic Security Engine, 10/100Base-T PHY				TQFP

INTERFACE: USB Port Power Controllers with Charger Emulation										
Product	Description		USB Port Power Switch (55 mW)	Hi-Speed USB 2.0 Switch	Battery Charger Emulation Profiles	Output Current	Indicator Output	Current Measurement	Interface	Packages
UCS1001-3/4	USB Port Power Controller with Charger Emulation		1	1	9	Up to 2.5A	Charging/Attach Detect	-	Discrete I/O	20-pin 4 x 4 QFN
UCS1002-2	Programmable USB Port Power Controller with Charger Emulation		1	1	9 plus 1 programmable	Up to 2.5A	Charging	✓	I ² C™ / SMBus	20-pin 4 x 4 QFN

INTERFACE: mTouch™ AR1000 Resistive Touch Screen Controllers

Product	Type	Communication	Touch Screens Supported	A/D	Resolution	Power	Points Per Second	Operating Temp. Range (°C)	Static Protection	5 ku Pricing†	Special Features	Packages
AR1021	Analog Resistive	SPI, I²C™	All Manufacturers 4, 5 and 8 wire	Internal 10-bit Ratiometric	1024 × 1024	2.5V DC ±5% 5.5V DC ±5%	140 pps	-40 to +85	Per schematic	\$1.32	Controller driven calibration & Universal for all touch screens	20-pin SSOP (SS), SOIC (SO), QFN (ML)
AR1011	Analog Resistive	UART	All Manufacturers 4, 5 and 8 wire	Internal 10-bit Ratiometric	1024 × 1024	2.5V DC ±5% 5.5V DC ±5%	140 pps	-40 to +85	Per schematic	\$1.39	Controller driven calibration & Universal for all touch screens	20-pin SSOP (SS), SOIC (SO), QFN (ML)
AR1100	Analog Resistive	USB, UART	All Manufacturers 4, 5 and 8 wire	Internal 10-bit Ratiometric	1024 × 1024	3.3V DC ±5% 5.5V DC ±5%	150 pps	-40 to +85	Per schematic	\$1.61	Controller driven calibration & Universal for all touch screens	20-pin SSOP (SS), SOIC (SO), QFN (ML)
AR1100BRD	Analog Resistive	USB, RS-232	All Manufacturers 4, 5 and 8 wire	Internal 10-bit Ratiometric	1024 × 1024	3.3V DC ±5% 5.5V DC ±5%	150 pps	-40 to +85	Per schematic	\$12.78	Controller driven calibration & Universal for all touch screens	Board Module

SAFETY & SECURITY: Smoke Detector and Horn Driver ICs

Product	Horn Driver	Detection Method	Low Battery Detection	Alarm Memory	Alarm Interconnect	Hush/Sensitivity Timer	Operating Temperature Range (°C)	Packages
RE46C140/1/3/4/5	Yes	Photo	Yes	No	Yes	140/4/5	-25 to +75	PDIP, SOIC
RE46C12X & 152	Yes	Ion	Yes	No	Not 120	122/7,152	-10 to +60	PDIP
RE46C10X & 11X	Yes	Just Driver	5/7/9/19	NA	9/19	None	See Datasheet	See Datasheet
RE46C162/3, 5/6/7/8	Yes	Ion/Photo	Yes	Yes	Yes	Yes	-25 to +75	PDIP, SOIC
RE46C180	Yes	Ion	Yes	Yes	Yes	Yes	-10 to +60	PDIP, SOIC
RE46C190	Yes	Photo	Yes	Yes	Yes	Yes	-10 to +60	SOIC
RE46C317/8	Yes	Just Driver	No	No	No	No	-10 to +60	PDIP, SOIC

MOTOR DRIVERS: Stepper Motors, DC Motors and 3 Phase BLDC Fan Controllers

Product	Motor Type	Input Voltage Range (V)	Internal/External FETs	Output Current (mA)	Control Scheme	Motor Speed Output	Protections	Temp. Operating Range (°C)	Features	Packages
MTS62C19A	One Bipolar Stepper Motor or Two DC Motors	10.0 to 40.0	Internal	750	Direct PWM Input, Current Limit Control, Microstepping	No	Overcurrent, Overtemperature, Under Voltage	-40 to +105	Dual Full Bridge Motor Driver for Stepper Motors, Pin Compatible with Allegro 6219	24-pin SOP
MTS2916A	One Bipolar Stepper Motor or Two DC Motors	10.0 to 40.0	Internal	750	Direct PWM Input, Current Limit Control, Microstepping	No	Overcurrent, Overtemperature, Under Voltage	-40 to +105	Dual Full Bridge Motor Driver for Stepper Motors, Pin Compatible with Allegro 2916	24-pin SOP
MTD6505	3-Phase Brushless DC Motor	2.0 to 5.5	Internal	750	Sensorless Sinusoidal	Frequency Generator	Overcurrent, Overvoltage, Short Circuit, Overtemperature, Motor Lock-up	-40 to +125	180° Sinusoidal Sensorless Drive, Direction Control, Programmable BEMF Coefficient Range, fsw = 30 kHz	10-pin UDFN (3 x 3)
MTD6501C/D/G	3-Phase Brushless DC Motor	2.0 to 14.0	Internal	800/500/800	Sensorless Sinusoidal	Frequency Generator	Overcurrent, Short Circuit Overtemperature, Motor Lock-up	-30 to +95	180° Sinusoidal Sensorless Drive, Direction Control, Boost Mode (D), fsw = 20 kHz (C/D), 23 kHz (G)	8-pin SOP (C, G), 10-pin MSOP (D)
MTD6502B	3-Phase Brushless DC Motor	2.0 to 5.5	Internal	750	Sensorless Sinusoidal	Frequency Generator	Overcurrent, Short Circuit Overtemperature, Motor Lock-up	-40 to +125	180° Sinusoidal Sensorless Drive, Direction Control, fsw = 30 kHz	10-pin TDFN (3 x 3)

REAL-TIME CLOCK/CALENDAR (RTCC)

Bus	Product	Pins	Timing Features				Memory ⁽¹⁾			Power		Unique Features ⁽²⁾	5 ku Pricing†	Packages
			Digital Trimming (Adj./Range)	Alarm Settings	WDT	Outputs	SRAM (Bytes)	EERPOM (Kbits)	ID/MAC (Bits)	Min Vcc	Min Ibat			
I²C	MCP7940M	8	±127 ppm	1 sec.	—	IRQ/CLK	64	0	0	1.8	—	—	\$0.46	SOIC (SN), TSSOP (ST), MSOP (MS), TDFN (MNY), PDIP (P)
	MCP7940N	8	±127 ppm	1 sec.	—	IRQ/CLK	64	0	0	1.8	1.3	Power Fail Timestamp	\$0.59	SOIC (SN), TSSOP (ST), MSOP (MS), TDFN (MNY), PDIP (P)
	MCP7940X	8	±127 ppm	1 sec.	—	IRQ/CLK	64	0	64	1.8	1.3	Power Fail Timestamp	\$0.66	SOIC (SN), TSSOP (ST), MSOP (MS), TDFN (MNY)
	MCP7941X	8	±127 ppm	1 sec.	—	IRQ/CLK	64	1	64	1.8	1.3	Power Fail Timestamp	\$0.72	SOIC (SN), TSSOP (ST), MSOP (MS), TDFN (MNY)
I²C	MCP7951X	10	±255 ppm	0.01 sec.	—	IRQ/CLK	64	1	128	1.8	1.3	Power Fail Timestamp	\$0.90	SOIC (SL), TSSOP (ST)
	MCP7952X	10	±255 ppm	0.01 sec.	—	IRQ/CLK	64	2	128	1.8	1.3	Power Fail Timestamp	\$0.96	MSOP (MS), TDFN (MN)
	MCP795W1X	14	±255 ppm	0.01 sec.	✓	1. CLK 2. IRQ 3. WDT RST	64	1	128	1.8	1.3	Power Fail Timestamp, Event Detects (x 2)	\$1.22	SOIC (SL), TSSOP (ST)
	MCP795W2X	14	±255 ppm	0.01 sec.	✓	1. CLK 2. IRQ 3. WDT RST	64	2	128	1.8	1.3	Power Fail Timestamp, Event Detects (x 2)	\$1.28	SOIC (SL), TSSOP (ST)

Note 1: All part numbers with an "X" have three ID programming options: [0 = Blank ID], [1 = EU-48™ MAC Address], [2 = EUI-64™ MAC Address]

Note 2: The Power Fail Timestamp in all RTCCs occur at Battery Switchover.

Products sorted by pin count followed by pricing.

† Pricing subject to change; please contact your Microchip representative for most current pricing.

Serial Memory Products																Special/Unique Features	
Bus	Product	Released (R) Not Released (NR)	Density	Organization	Max. Clock Frequency	Operating Voltage	Temperature Range			E/W Endurance (Minimum)	Data Retention (Minimum)	Max. Write Speeds	Max. Standby Current (@ 5.5V, 85°C)	Write Protect	Protected Array Size	5 ku Pricing†	
Serial SRAM																	
SPI	23X640	R	64 Kb	x 8	20 MHz	1.5V-1.95V 2.7V-3.6V	-40°C to +125°C	∞	Volatile	0 ms	4 μA	-	-	\$0.51	Zero write cycle time, Infinite endurance, Volatile RAM, Byte/page/sequential read-write modes	PDIP (P), SOIC (SN), TSSOP (ST)	
	23X256	R	256 Kb	x 8	20 MHz	1.5V-1.95V 2.7V-3.6V	-40°C to +125°C	∞	Volatile	0 ms	4 μA	-	-	\$0.87	Zero write cycle time, Infinite endurance, Volatile RAM, Byte/page/sequential read-write modes	PDIP (P), SOIC (SN), TSSOP (ST)	
	23XX512	R	512 Kb	x 8	20 × 4 MHz	1.7V-2.2V 2.5V-5.5V	-40°C to +125°C	∞	Volatile	0 ms	4 μA	-	-	\$1.24	Fast Speed: Quad SPI available (80 MHz); Infinite endurance; Zero write times, 5V capable	SOIC (SN), PDIP (P), TSSOP (ST)	
	23XX1024	R	1024 Kb	x 8	20 × 4 MHz	1.7V-2.2V 2.5V-5.5V	-40°C to +125°C	∞	Volatile	0 ms	4 μA	-	-	\$1.73	Fast Speed: Quad SPI available (80 MHz); Infinite endurance; Zero write times, 5V capable	SOIC (SN), PDIP (P), TSSOP (ST)	
Serial NVRAM																	
SPI	23LCV512	R	512 Kb	x 8	20 MHz	-	-40°C to +125°C	∞	20 Years via battery	0 ms	4 μA	-	-	\$1.40	Battery backed non-volatile SRAM; Infinite endurance; Zero write times	SOIC (SN), PDIP (P), TSSOP (ST)	
	23LCV1024	R	1024 Kb	x 8	20 MHz	-	-40°C to +125°C	∞	20 Years via battery	0 ms	4 μA	-	-	\$1.98	Battery backed non-volatile SRAM; Infinite endurance; Zero write times	SOIC (SN), PDIP (P), TSSOP (ST)	
Serial EEPROM																	
UNI/O® Bus	11XX010	R	1 Kb	x 8	100 kHz	1.8V-5.5V	-40°C to +125°C	1M	200 Years	5 ms	1 μA	-	✓	W, ½, ¼	\$0.23	Single I/O for all clock, data, control and write protection	PDIP (P), SOIC (SN), MSOP (MS), DFN (MNY), T0-92 (TO), 3-SOT-23 (TT), WLCSP (CS)
	11XX020/E48/E64/UID	R	2 Kb	x 8	100 kHz	1.8V-5.5V	-40°C to +125°C	1M	200 Years	5 ms	1 μA	-	✓	W, ½, ¼	\$0.25	Single I/O for all clock, data, control and write protection, Unique EUI-48™/EUI-64™ MAC address and unique ID options available	PDIP (P), SOIC (SN), MSOP (MS), DFN (MNY), T0-92 (TO), 3-SOT-23 (TT), WLCSP (CS)
	11XX040	R	4 Kb	x 8	100 kHz	1.8V-5.5V	-40°C to +125°C	1M	200 Years	5 ms	1 μA	-	✓	W, ½, ¼	\$0.26	Single I/O for all clock, data, control and write protection	PDIP (P), SOIC (SN), MSOP (MS), DFN (MNY), T0-92 (TO), 3-SOT-23 (TT), WLCSP (CS)
	11XX080	R	8 Kb	x 8	100 kHz	1.8V-5.5V	-40°C to +125°C	1M	200 Years	5 ms	1 μA	-	✓	W, ½, ¼	\$0.30	Single I/O for all clock, data, control and write protection	PDIP (P), SOIC (SN), MSOP (MS), DFN (MNY), T0-92 (TO), 3-SOT-23 (TT), WLCSP (CS)
	11XX160	R	16 Kb	x 8	100 kHz	1.8V-5.5V	-40°C to +125°C	1M	200 Years	5 ms	1 μA	-	✓	W, ½, ¼	\$0.33	Single I/O for all clock, data, control and write protection	PDIP (P), SOIC (SN), MSOP (MS), DFN (MNY), T0-92 (TO), 3-SOT-23 (TT), WLCSP (CS)
I²C™	24XX00	R	128 b	x 8	400 kHz	1.7V-5.5V	-40°C to +125°C	1M	200 Years	4 ms	1 μA	-	-	-	\$0.17	100 kHz operation from 1.7V to 4.5V	PDIP (P), SOIC (SN), TSSOP (ST), DFN (MNY), 5-SOT-23 (OT)
	24XX01/014	R	1 Kb	x 8	400 kHz	1.7V-5.5V 1.5V-3.6V	-40°C to +150°C	1M	200 Years	5 ms	1 μA	✓	-	W, ½	\$0.18	Address pin option: connect up to 8 devices on bus, Very low voltage option	PDIP (P), SOIC (SN), TSSOP (ST), MSOP (MS), DFN (MNY), 5-SOT-23 (OT), SC70 (LT)
	24XX02/024/E48/E64/UID	R	2 Kb	x 8	400 kHz	1.7V-5.5V 1.5V-3.6V	-40°C to +125°C	1M	200 Years	5 ms	1 μA	✓	-	W, ½	\$0.20	Address pin option: connect up to 8 devices on bus, Very low voltage option, Unique EUI-48/EUI-64 MAC address and unique ID options available	PDIP (P), SOIC (SN), TSSOP (ST), MSOP (MS), DFN (MNY), 5-SOT-23 (OT), SC70 (LT)
	34XX02	R	2 Kb	x 8	1 MHz	1.7V-5.5V 1.5V-3.6V	-40°C to +125°C	1M	200 Years	5 ms	1 μA	✓	✓	W, ½	\$0.18	1 MHz @ 2.5V, Permanent and restable software WP – DIMM-DDR2/3	PDIP (P), SOIC (SN), TSSOP (ST), MSOP (MS), DFN (MNY), 6-SOT-23 (OT)
	24XX04	R	4 Kb	x 8	400 kHz	1.7V-5.5V	-40°C to +125°C	1M	200 Years	5 ms	1 μA	✓	-	W, ½	\$0.21	400 kHz @ 2.5V, 16 byte page write buffer, No address pins	PDIP (P), SOIC (SN), TSSOP (ST), MSOP (MS), DFN (MNY), 5-SOT-23 (OT), WLCSP (CS)
	24XX08	R	8 Kb	x 8	400 kHz	1.7V-5.5V	-40°C to +125°C	1M	200 Years	5 ms	1 μA	✓	-	W, ½	\$0.23	400 kHz @ 2.5V, 16 byte page write buffer, No address pins	PDIP (P), SOIC (SN), TSSOP (ST), MSOP (MS), DFN (MNY), 5-SOT-23 (OT),
	24XX16	R	16 Kb	x 8	400 kHz	1.7V-5.5V	-40°C to +125°C	1M	200 Years	5 ms	1 μA	✓	-	W, ½	\$0.25	400 kHz @ 2.5V, 16 byte page write buffer, No address pins	PDIP (P), SOIC (SN), TSSOP (ST), MSOP (MS), DFN (MNY), 5-SOT-23 (OT), WLCSP (CS)
	24XX32A	R	32 Kb	x 8	400 kHz	1.7V-5.5V	-40°C to +125°C	1M	200 Years	5 ms	1 μA	✓	-	W, ¼	\$0.31	400 kHz @ 2.5V, 32 byte page write buffer, connect up to 8 devices on bus	PDIP (P), SOIC (SN), TSSOP (ST), MSOP (MS), DFN (MNY), 5-SOT-23 (OT), WLCSP (CS)
	24XX64/65	R	64 Kb	x 8	1 MHz	1.7V-5.5V	-40°C to +125°C	1M, 10M	200 Years	5 ms	1 μA	✓	-	W, ¼	\$0.38	1 MHz @ 2.5V, 32/64 byte page, Relocatable 4 Kb block with 10M cycles endurance	PDIP (P), SOIC (SN), TSSOP (ST), MSOP (MS), DFN (MNY), 5-SOT-23 (OT), WLCSP (CS)
	24XX128	R	128 Kb	x 8	1 MHz	1.7V-5.5V	-40°C to +125°C	1M	200 Years	5 ms	1 μA	✓	-	W	\$0.54	1 MHz @ 2.5V, 64 byte page, Connect up to 8 devices on bus	PDIP (P), SOIC (SN), TSSOP (ST), MSOP (MS), DFN (MNY), WLCSP (CS)
	24XX256/UID	R	256 Kb	x 8	1 MHz	1.7V-5.5V	-40°C to +125°C	1M	200 Years	5 ms	1 μA	✓	-	W	\$0.83	1 MHz @ 2.5V, 64 byte page, Connect up to 8 devices on bus, EUI-48, EUI-64 & unique ID options available	PDIP (P), SOIC (SN), TSSOP (ST), SOJ (SM), MSOP (MS), DFN (MF), WLCSP (CS), TDFN (MNY)
	24XX512	R	512 Kb	x 8	1 MHz	1.7V-5.5V	-40°C to +125°C	1M	200 Years	5 ms	1 μA	✓	-	W	\$1.50	1 MHz @ 2.5V, 128 byte page, Connect up to 8 devices on bus	PDIP (P), SOIC (SN), TSSOP (ST), DFN (MF), SOJ (SM), WLCSP (CS)
	24XX1025/26	R	1 Mb	x 8	1 MHz	1.7V-5.5V	-40°C to +125°C	1M	200 Years	5 ms	5 μA	✓	-	W	\$3.14	1 MHz @ 2.5V, 128 byte page, Connect up to 4 devices on bus	PDIP (P), SOIC (SN), SOJ (SM)
	24XX1024	NR	1 Mb	x 8	1 MHz	2.5V-5.5V	-40°C to +125°C	1M	200 Years	5 ms	5 μA	✓	-	W	-	1 MHz @ 2.5V, 256 byte page, Connect up to 4 devices on bus	PDIP (P), SOIC (SN), TSSOP (ST), DFN (MF), SOJ (SM)

1: All devices are Pb-Free and RoHS compliant.

2: ESD protection > 4kV (HBM); > 400V (MM) on all pins.

3: Write Protect (WP); W = Whole Array, ½ = Half Array, ¼ = Quarter Array.

4: Factory program and unique ID options available.

5: Die and wafer options available on all devices.

† Pricing subject to change; please contact your Microchip representative for most current pricing.

SERIAL MEMORY PRODUCTS

Bus	Product	Released (R) Not Released (NR)	Density	Organization	Max. Clock Frequency	Operating Voltage	Temperature Range	E/W Endurance (Minimum)	Data Retention (Minimum)	Max. Write Spreads	Max. Standby Current (@ 5.5V, 85 °C)	Write Protect		Protected Array Size	5 Ku Pricing†	Special/Unique Features	Packages
												Hardware	Software				
Serial EEPROM (Cont.)																	
Microwire	93XX46A/B/C	R	1 Kb	x 8/x 16	3 MHz	1.8V-5.5V	-40°C to +125°C	1M	200 Years	6 ms	1 μA	-	-	-	\$0.18	ORG pin to select word size on 46C version	PDIP (P), SOIC (SN), TSSOP (ST), MSOP (MS), DFN (MNY), 6-SOT-23 (OT)
	93XX56A/B/C	R	2 Kb	x 8/x 16	3 MHz	1.8V-5.5V	-40°C to +125°C	1M	200 Years	6 ms	1 μA	-	-	-	\$0.20	ORG pin to select word size in 56C version	PDIP (P), SOIC (SN), TSSOP (ST), MSOP (MS), DFN (MNY), 6-SOT-23 (OT)
	93XX66A/B/C	R	4 Kb	x 8/x 16	3 MHz	1.8V-5.5V	-40°C to +125°C	1M	200 Years	6 ms	1 μA	-	-	-	\$0.21	ORG pin to select word size in 66C version	PDIP (P), SOIC (SN), TSSOP (ST), MSOP (MS), DFN (MNY), 6-SOT-23 (OT)
	93XX76A/B/C	R	8 Kb	x 8/x 16	3 MHz	1.8V-5.5V	-40°C to +125°C	1M	200 Years	6 ms	1 μA	✓	-	W	\$0.30	ORG pin to select word size in 76C version	PDIP (P), SOIC (SN), TSSOP (ST), MSOP (MS), DFN (MNY), 6-SOT-23 (OT)
	93XX86A/B/C	R	16 Kb	x 8/x 16	3 MHz	1.8V-5.5V	-40°C to +125°C	1M	200 Years	6 ms	1 μA	✓	-	W	\$0.33	ORG pin to select word size in 86C version	PDIP (P), SOIC (SN), TSSOP (ST), MSOP (MS), DFN (MNY), 6-SOT-23 (OT)
SPI	25XX010A	R	1 Kb	x 8	10 MHz	1.8V-5.5V	-40°C to +150°C	1M	200 Years	5 ms	1 μA	✓	✓	W, ½, ¼	\$0.30	5 MHz @ 2.5V, Status register, 16 byte page	PDIP (P), SOIC (SN), TSSOP (ST), MSOP (MS), DFN (MNY), 6-SOT-23 (OT)
	25XX020A/E48/E64/UID	R	2 Kb	x 8	10 MHz	1.8V-5.5V	-40°C to +150°C	1M	200 Years	5 ms	1 μA	✓	✓	W, ½, ¼	\$0.31	5 MHz @ 2.5V, Status register, 16 byte page, Unique EUI-48™/EUI-64™ MAC address and unique ID options available	PDIP (P), SOIC (SN), TSSOP (ST), MSOP (MS), DFN (MNY), 6-SOT-23 (OT)
	25XX040A	R	4 Kb	x 8	10 MHz	1.8V-5.5V	-40°C to +150°C	1M	200 Years	5 ms	1 μA	✓	✓	W, ½, ¼	\$0.33	5 MHz @ 2.5V, Status register, 16 byte page	PDIP (P), SOIC (SN), TSSOP (ST), MSOP (MS), DFN (MNY), 6-SOT-23 (OT)
	25XX080C/D	R	8 Kb	x 8	10 MHz	1.8V-5.5V	-40°C to +150°C	1M	200 Years	5 ms	1 μA	✓	✓	W, ½, ¼	\$0.40	16/32 byte page, 5 MHz @ 2.5V, Status register	PDIP (P), SOIC (SN), TSSOP (ST), MSOP (MS), DFN (MNY)
	25XX160C/D	R	16 Kb	x 8	10 MHz	1.8V-5.5V	-40°C to +150°C	1M	200 Years	5 ms	1 μA	✓	✓	W, ½, ¼	\$0.41	16/32 byte page, 5 MHz @ 2.5V, Status register	PDIP (P), SOIC (SN), TSSOP (ST), MSOP (MS), DFN (MNY)
	25XX320A	R	32 Kb	x 8	10 MHz	1.8V-5.5V	-40°C to +150°C	1M	200 Years	5 ms	1 μA	✓	✓	W, ½, ¼	\$0.45	5 MHz @ 2.5V, Status register, 32 byte page	PDIP (P), SOIC (SN), TSSOP (ST), MSOP (MS), DFN (MNY)
	25XX640A	R	64 Kb	x 8	10 MHz	1.8V-5.5V	-40°C to +150°C	1M	200 Years	5 ms	1 μA	✓	✓	W, ½, ¼	\$0.46	5 MHz @ 2.5V, Status register, 32 byte page	PDIP (P), SOIC (SN), TSSOP (ST), MSOP (MS), DFN (MNY, MF)
	25XX128	R	128 Kb	x 8	10 MHz	1.8V-5.5V	-40°C to +150°C	1M	200 Years	5 ms	1 μA	✓	✓	W, ½, ¼	\$0.74	5 MHz @ 2.5V, Status register, 64 byte page	PDIP (P), SOIC (SN), TSSOP (ST), DFN (MF)
	25XX256	R	256 Kb	x 8	10 MHz	1.8V-5.5V	-40°C to +150°C	1M	200 Years	5 ms	1 μA	✓	✓	W, ½, ¼	\$1.01	5 MHz @ 2.5V, Status register, 64 byte page	PDIP (P), SOIC (SN), TSSOP (ST), DFN (MF), SOU (SM)
	25XX512	R	512 Kb	x 8	20 MHz	1.8V-5.5V	-40°C to +125°C	1M	200 Years	5 ms	10 μA	✓	✓	W, ½, ¼	\$1.53	10 MHz @ 2.5V, Deep power down, Status register, Page/sector/chip erase	PDIP (P), SOIC (SN), DFN (MF), SOU (SM)
	25XX1024	R	1 Mb	x 8	20 MHz	1.8V-5.5V	-40°C to +125°C	1M	200 Years	6 ms	12 μA	✓	✓	W, ½, ¼	\$2.59	10 MHz @ 2.5V, Deep power down, Status register, Page/sector/chip erase	PDIP (P), DFN (MF), SOU (SM)

1: All devices are Pb-Free and RoHS compliant.

2: ESD protection > 4kV (HBM); > 400V (MM) on all pins.

3: Write Protect (WP); W = Whole Array, ½ = Half Array, ¼ = Quarter Array.

4: Factory program and unique ID options available.

5: Die and wafer options available on all devices.

† Pricing subject to change; please contact your Microchip representative for most current pricing.

USB						
Product	Description	Processor Interface	# of Downstream Ports	Card Formats	Industrial Version	Package
USB Hub Controllers						
USB2412	2-Port USB 2.0 Hi-Speed Hub	USB 2.0	2	N/A	-	28-pin QFN
USB2422	Small-footprint, 2-Port value hub, Commercial and Industrial Temperature with USB Battery Charging 1.1	USB 2.0	2	N/A	✓	24-pin QFN
USB251XB	USB2.0 Hi-Speed Hub w/Battery Charger Detection	USB 2.0	2, 3, 4, 7 port options	N/A	✓	36- or 64-pin QFN
USB2524	4-Port USB 2.0 Hi-Speed Multi-Switch Hub	USB 2.0 x 2	4	N/A	-	56-pin QFN
USB3503A	3-Port USB 2.0 Hi-Speed HSIC Hub for Mobile Applications	HSIC	3	N/A	✓	25-ball WLCSP
USB3803B	3-Port USB 2.0 Hi-Speed Hub for Mobile Applications	USB 2.0	3	N/A	✓	25-ball WLCSP
USB553XB	USB 3.0 SuperSpeed Hub w/Battery Charger Detection	USB 3.0	4, 7 port options	N/A	✓	64- or 72-pin QFN
USB3X13	3-Port USB 2.0 Hi-Speed Controller Hub for Mobile Applications	USB 2.0 or HSIC	3 (USB 2.0 x2; HSIC x1)	N/A	✓	30-ball WLCSP
USB253X	USB 2.0 Hi-Speed Controller Hub w/Battery Charger Detection	USB 2.0	2, 3, 4 port options	N/A	✓	36-pin QFN
USB46X4	USB 2.0 Hi-Speed Controller Hub w/USB and HSIC Interfaces	USB 2.0 or HSIC	4 (USB 2.0 x4 or USB 2.0 x2/HSIC x2)	N/A	✓	48-pin QFN
USB Transceivers/Switches						
USB333X	Mobile Hi-Speed USB 2.0 Transceiver with Multi-frequency Support	ULPI	-	-	✓	25-ball WLCSP
USB3340	Hi-Speed USB 2.0 Transceiver with Multi-frequency Support	ULPI	-	-	✓	24- or 32-pin QFN
USB3300	Hi-Speed USB 2.0 Transceiver (24 MHz reference clock support)	ULPI	-	-	✓	32-pin QFN
USB3740B	Hi-Speed USB 2.0 Switch with Extremely Low Power	USB 2.0	-	-	✓	10-pin QFN
USB375XA-X	Hi-Speed USB 2.0 Port Protection with Switch and Charger Detection	USB 2.0	-	-	✓	16-pin QFN
USB Flash Media Controllers						
USB224X	Hi-Speed USB 2.0 Multi-Format Flash Media Controller	USB 2.0	-	SD™/MMC/eMMC™/MS/xD	✓	36-pin QFN
USB225X	Hi-Speed USB 2.0 Multi-Format Flash Media Controller	USB 2.0	-	SD/MMC/eMMC/MS/xD/CF	✓	128-pin VTQFP
USB260X	Hi-Speed USB 2.0 Multi-Format Flash Media Hub Controller with Card Power	USB 2.0	3	SD/MMC/eMMC/MS/CF	-	128-pin VTQFP
USB264X	Hi-Speed USB 2.0 Multi-Format Flash Media Hub Controller	USB 2.0	2	SD/MMC/eMMC/MS/xD	✓	48-pin QFN
USB2660	Hi-Speed USB 2.0 Multi-Format Flash Media Hub Controller	USB 2.0	2	SD/MMC/eMMC/MS/xD (x2)	✓	64-pin QFN
USB4640	Hi-Speed USB 2.0 Multi-Format Flash Media HSIC Hub Controller	HSIC	2	SD/MMC/eMMC/MS/xD	✓	48-pin QFN

ETHERNET							
Product	Description	Interface (Upstream)	Wake-on-LAN	EEE	Industrial Version	Packages	
Ethernet Controllers							
ENC28J60	10Base-T Ethernet Controller	SPI	-	-	✓	28-pin SPDIP, SSOP, SOIC, QFN	
ENC624J600	10Base-T/100Base-TX Ethernet Controller with Security	SPI, Parallel	-	-	✓	24-pin TQFN, QFN, 64-pin TQFN	
LAN9217	10Base-T/100Base-TX Ethernet Controller with 16-bit/MII Interface	16-bit Host Bus, MII	-	-	-	100-pin TQFP	
LAN9218	10Base-T/100Base-TX Ethernet Controller with 32-bit Interface	32-bit Host Bus	-	-	✓	100-pin TQFP	
LAN9220	10Base-T/100Base-TX Ethernet Controller with 16-bit Interface	16-bit Host Bus	-	-	-	56-pin QFN	
LAN9221	10Base-T/100Base-TX Ethernet Controller with 16-bit Interface	16-bit Host Bus	-	-	✓	56-pin QFN	
LAN9420	10Base-T/100Base-TX Ethernet Controller with 32-bit PCI Interface	32-bit PCI 3.0	-	-	✓	128-pin VTQFP	
Ethernet Switches							
LAN9303	10/100 3-port Managed Ethernet Switches	MII/RMII/Turbo MII	-	-	✓	56-pin QFN	
LAN9303M	10/100 3-port Managed Ethernet Switches	MII/RMII/Turbo MII	-	-	✓	72-pin QFN	
LAN9311	10/100 2-port Managed Ethernet Switches with Local Bus Interface	16-bit Host Bus	-	-	✓	128-pin VTQFP, XVTQFP	
LAN9312	10/100 2-port Managed Ethernet Switches with Local Bus Interface	32-bit Host Bus	-	-	-	128-pin VTQFP, XVTQFP	
LAN9313	10/100 3-port Managed Ethernet Switches	MII/RMII/Turbo MII	-	-	✓	128-pin VTQFP, XVTQFP	
USB to Ethernet							
LAN9500A	USB 2.0 to 10/100 Ethernet Controllers	USB 2.0	-	-	✓	56-pin QFN	
LAN9730	USB HSIC 2.0 to 10/100 Ethernet Controllers	USB 2.0 (HSIC), MII	-	-	✓	56-pin QFN	
LAN7500	USB 2.0 to 10/100/1000 Ethernet Controllers	USB 2.0	-	-	✓	56-pin QFN	
LAN9512	USB 2.0 to 10/100 Ethernet Controllers with 2-port USB 2.0 Hub	USB 2.0	-	-	✓	64-pin QFN	
LAN9513	USB 2.0 to 10/100 Ethernet Controllers with 3-port USB 2.0 Hub	USB 2.0	-	-	✓	64-pin QFN	
LAN9514	USB 2.0 to 10/100 Ethernet Controllers with 4-port USB 2.0 Hub	USB 2.0	-	-	✓	64-pin QFN	
Ethernet Transceivers							
LAN8710A	Small Footprint, Low Power Consumption, Full-Featured 10/100 Ethernet Transceivers	MII/RMII	-	-	✓	32-pin QFN	
LANB720A	Small Footprint, Low Power Consumption, Full-Featured 10/100 Ethernet Transceivers	RMII	-	-	✓	24-pin QFN	
LAN8740A	Small-Footprint, 10/100 PHY Family Featuring Energy Efficient Ethernet and Wake-On-LAN	MII/RMII	✓	✓	✓	32-pin QFN	
LAN8741A	Small-Footprint, 10/100 PHY Family Featuring Energy Efficient Ethernet	MII/RMII	-	✓	✓	32-pin QFN	
LAN8742A	Small-Footprint, 10/100 PHY Family Featuring Wake-On-LAN	RMII	✓	-	✓	24-pin QFN	
LAN8810	GMII 10/100/1000 Ethernet Transceiver with HP Auto-MDIX Support	GMII	-	-	✓	72-pin QFN	
LAN8820	RGMII 10/100/1000 Ethernet Transceiver with HP Auto-MDIX Support	RGMII	-	-	✓	56-pin QFN	

*Note: All products above are supported with 3.3V operating voltage

AUTOMOTIVE: MOST® (Media Oriented Systems Transport) Network Interface Controllers						
Intelligent Network Interface Controller (INIC) for MOST Networks						
Product	Features	Interface	Temperature Range	Pin	Packages	
OS81110 INIC	Fully-encapsulated, single-chip, embedded network management, supports MOST embedded Ethernet channel and isochronous channels (MOST150)	MOST150 FOT or MOST150 coax transceiver, I ^C TM, I ^S TM/SPDIF, TSI, SPI, MediaLB®	-40° to 105°C	48	QFN	
OS81082 INIC	Fully-encapsulated, single-chip, embedded network management (MOST50)	MOST50 electrical (UTP), I ^C , I ^S , MediaLB	-40° to 95°C	64	ETQFP	
OS81092 INIC	ROM version of OS81082 INIC (MOST50)	MOST50 electrical (UTP), I ^C , I ^S , MediaLB	-40° to 105°C	48	QFN	
OS81050 INIC	Fully-encapsulated, single-chip with embedded network management (MOST25)	MOST25 FOT, I ^C , I ^S , MediaLB	Standard range: -40° to 85°C Extended range: -40° to 105°C	44	QFP, ETQFP	
OS81060 INIC	ROM version of OS81050 INIC (MOST25)	MOST25 FOT, I ^C , I ^S , MediaLB	-40° to 105°C (targeted)	40	QFN	

AUTOMOTIVE: Power Management Companion

For Diagnostics, Status Monitoring and Power Supply

Product	Features	Interface	Temperature Range	Pin	Packages
MPM8500	Power management companion for diagnostics, status monitoring and power supply	LIN 2.0, I ² C™	-40° to 105°C	24	QFN

AUTOMOTIVE: Multimedia I/O Companion

Multimedia I/O Port Expander

Product	Features	Interface	Temperature Range	Pin	Packages
OS85650	Low-cost multimedia I/O port expander, DTCP co-processor	MediaLB 3-pin and 6-pin, Host Bus Interface (HBI), 2 x multi-channel streaming ports, 2 x TSI, 2 x SPI, I ² C™	-40° to 105°C	128	ETQFP
OS85652	Low-cost multimedia I/O port expander	MediaLB 3-pin and 6-pin, Host Bus Interface (HBI), 2 x multi-channel streaming ports, 2 x TSI, 2 x SPI, I ² C™	-40° to 105°C	128	ETQFP
OS85656	Low-cost multimedia I/O port expander well-suited for streaming applications	MediaLB 3-pin, streaming port I ² S™ (FSYN, FCLK, 4 x IN, 4 x Out, @ 512 Fs), serial transport stream interface (TSI), I ² C™	-40° to 105°C	48	QFN
OS85654	Low-cost multimedia I/O port expander well-suited for streaming applications, DTCP co-processor	MediaLB 3-pin, streaming port I ² S (FSYN, FCLK, 4 x IN, 4 x Out, @ 512 Fs), serial transport stream interface (TSI), I ² C™	-40° to 105°C	48	QFN

AUTOMOTIVE: Ethernet Controllers

10/100 Ethernet Controllers with USB 2.0, HSIC or HBI

Product	Features	Interface	Temperature Range	Pin	Packages
LAN89218	High-performance, single-chip controller with HP Auto-MDIX support*	MAC/PHY, 10Base-T/100Base-TX, 32- and 16-bit Host Bus Interface (HBI)	-40° to 85°C	100	TQFP
LAN89530	Hi-Speed USB 2.0 to 10/100 Ethernet controller	USB 2.0	-40° to 85°C	56	QFN

*HP Auto MDIX eliminates the need for special "crossover" cables when connecting LAN devices together.

AUTOMOTIVE: Ethernet Switch

10/100 Managed Ethernet Switch with HP Auto-MDIX Support

Product	Features	Interface	Temperature Range	Ports	Pin	Packages
LAN89303	High-performance, small-footprint, full-featured, single MII/RMII/Turbo MII support	MII/RMII, 2 x 10/100 PHYs, 3 x 10/100 MACs	-40° to 85°C	4	56	QFN

AUTOMOTIVE: Ethernet Transceiver

10/100 Ethernet Transceiver with HP Auto-MDIX Support*, Featuring flexPWR® Technology

Product	Features	Interface	Temperature Range	Pin	Packages
LAN88730	Small-footprint, low-power consumption, full-featured	10Base-T/100Base-TX, MII/RMII	LAN88730AM: -40° to 85°C LAN88730BM: -40° to 105°C	32	QFN

*HP Auto MDIX eliminates the need for special "crossover" cables when connecting LAN devices together.

AUTOMOTIVE: Hi-Speed USB 2.0 Hub

USB 2.0 Hub Featuring MultiTRAK™ Technology

Product	Features	Interface	Temperature Range	Ports	Pin	Packages
USB82512	Versatile, cost-effective, energy-efficient, incorporating MultiTRAK™, PortMap, PortSwap, PHYBoost technologies	SMBus/I ² C™	-40° to 85°C	2	36	QFN
USB82513	Versatile, cost-effective, energy-efficient, incorporating MultiTRAK, PortMap, PortSwap, PHYBoost technologies	SMBus/I ² C	-40° to 85°C	3	36	QFN
USB82514	Versatile, cost-effective, energy-efficient, incorporating MultiTRAK, PortMap, PortSwap, PHYBoost technologies	SMBus/I ² C	-40° to 85°C	4	36	QFN

AUTOMOTIVE: Hi-Speed USB 2.0 Hub and Flash Media Card Controllers

USB 2.0 Hub and Card Controller Combos

Product	Features	Socket Type	Supports	Temperature Range	USB Ports	Pin	Packages
USB82640	Features PortMap, PortSwap and PHYBoost technologies	Single	SD™/SD High Capacity™/MultiMediaCard™/Memory Stick®/MS PRO™, MS PRO-HG™	-40° to 85°C	2	48	QFN
USB82642	USB bridge/card reader combo with USB to SDIO and USB to I ² C™ bridging functionality and PortMap, PortSwap and PHYBoost technologies	Single	SD/SD High Capacity/MultiMediaCard/Memory Stick/MS PRO, MS PRO-HG	-40° to 85°C	2	48	QFN

AUTOMOTIVE: Hi-Speed USB 2.0 Transceiver

USB 2.0 Transceiver with 1.8V ULPI Interface

Product	Features	Interface	Temperature Range	Ports	Pin	Packages
USB83340	Multi-frequency reference clock	1.8V to 3.3V ULPI	-40° to 105°C	1	32	QFN

AUTOMOTIVE: Hi-Speed USB 2.0 Battery Charger

Standalone USB Battery Charger

Product	Features	Temperature Range	Supports	Pin	Packages
UCS81001	USB battery charger supporting BC1.2, China charging, Apple® and RIM® charging profiles as well as programmable charging profiles for unforeseen peripherals	-40° to 85°C	USB, I ^C ™, SMBus	28	QFN
UCS81002	USB battery charger supporting BC1.2, China charging, Apple and RIM charging profiles as well as programmable charging profiles for unforeseen peripherals	-40° to 85°C	USB, I ^C , SMBus	28	QFN

AUTOMOTIVE: Wireless Audio

Radio Frequency Digital Audio Transceiver

Product	Features	Typical Sink Mode Power Consumption	PA Output Power	Audio	Qualification
KLR83012	Wirelessly streams uncompressed lossless audio up to 25m over robust 2.4 GHz radio link, multi-point to multi-point connectivity, strong Wi-Fi® coexistence, data channel for audio playback control, very low power consumption	20 mW	1.5 dBm	16 bit, 44.1 Ks/s stereo	AEC Q100

AUTOMOTIVE: Capacitive Touch Sensors

Product	Features	Input Channels	LED Drivers	Proximity Included	Interface	Pin	Packages
CAP81188	Reset, wake and alert, automatic recalibration, base capacitance compensation	8	8	✓	I ^C ™/SPI/SMSC BC-Link™	24	QFN

PC SYSTEM & I/O CONTROLLERS: Notebook PC Products

Embedded Controller and I/O Devices for Notebook PC Platforms

Product	Features	I/O Ports	System Interface	Pin	Packages
MEC1621	32-bit embedded controller with 192K bytes embedded flash, 1K bytes EEPROM, 16K bytes SRAM, ADC, temp sensing, connected standby support	3 PS/2, 3 SMBus, 2 SPI, 16 PWM, 6 tachs, 1 serial (2-pin), 16 ADC channels, 4 temp inputs, 3 LED, 1 HDMI-CEC, 146 GPIOs, 3 SMSC BC-Link™	LPC/SMBus	176/225	LFBGA, LFBGA
MEC1620	32-bit embedded controller with 192K bytes embedded flash, 1K bytes EEPROM, 16K bytes SRAM, ADC, connected standby support	3 PS/2, 3 SMBus, 2 SPI, 16 PWM, 6 tachs, 1 serial (2-pin), 16 ADC channels, 3 LED, 1 HDMI-CEC, 153 GPIOs, 3 SMSC BC-Link	LPC/SMBus	176	LFBGA, LFBGA
MEC1308	8-bit embedded controller with 64K bytes SRAM, SPI Flash Memory Interface, ADC, Consumer IR, SMSC BC-Link technology	4 PS/2, 2 SMBus, 4 PWMs, 2 tachs, 1 serial (2-pin), 55 GPIOs, RC-6 CIR, 1 SMSC BC-Link	LPC/SMBus	128/144	VTQFP, TFBGA
MEC1312	8-bit embedded controller with 96K bytes SRAM, SPI Flash Memory Interface, PECI, ADC, PID Fan Control, SMSC BC-Link technology	4 PS/2, 3 SMBus, PECI, 4 PWMs, 2 tachs, 1 serial (2-pin), 63 GPIOs, 1 SMSC BC-Link	LPC/SMBus	128	VTQFP
SIO1028	Super I/O controller, small form factor package	3 serial, 24 GPIOs	LPC	64	QFN
LPC47N217	Super I/O controller for notebook and embedded PC applications	1 serial, 1 parallel, 14 GPIOs, IrDA®, CIR	LPC	64/56	STQFP
LPC47N217N	Super I/O controller for notebook and embedded PC applications	1 serial, 1 parallel, 14 GPIOs	LPC	64/56	STQFP, QFN
ECE1088	GPIO expander with SMSC BC-Link technology	20 GPIOs	SMBus or SMSC BC-Link	28	QFN
ECE1099	GPIO expander with Keyscan and SMSC BC-Link technology	32 GPIOs, 23:8 Keyscan	SMBus or SMSC BC-Link	40	QFN
ECE1105	GPIO expander with Keyscan, PS/2 and SMSC BC-Link technology	40 GPIOs, 23:8 Keyscan, 2 PS/2	SMBus or SMSC BC-Link	48	QFN

PC SYSTEM & I/O CONTROLLERS: Desktop PC Products

Embedded Controller and Highly-Integrated Super I/O Devices for Desktop PC Platforms

Product	Features	I/O Ports	System Interface	Pin	Packages
SCH5636	Desktop embedded controller, embedded SRAM for custom applications, closed-loop fan control, PECI 3.0 support, temperature and voltage monitoring	FDC, parallel, 2 serial, 8042 KB controller, 2 SMBus, 4 PWMs, 4 tachs, 60 GPIOs	LPC	128	QFP
SCH5627	Desktop embedded controller, SMBus master for PCH temperature support, PECI 3.0 support, voltage monitoring	FDC, parallel, 2 serial, 8042 KB controller, 2 SMBus, 4 PWMs, 4 tachs, 60 GPIOs	LPC	128	QFP
SCH5627P	Desktop embedded controller with "XLS5" power savings mode, SMBus master for PCH temperature support, PECI 3.0 support and voltage monitoring	FDC, parallel, 2 serial, 8042 KB controller, 2 SMBus, 4 PWMs, 4 tachs, 60 GPIOs	LPC	128	QFP
SCH5147	Super I/O controller, LPC hardware monitoring, PECI support, voltage monitoring	FDC, parallel, 2 serial, 8042 KB controller, 2 SMBus, 3 PWMs, 3 tachs, 29 GPIOs	LPC	128	QFP

PC SYSTEM & I/O CONTROLLERS: Server/Workstation Products

Embedded Controller and Super I/O Devices for Server and Workstation PC Platforms

Product	Features	I/O Ports	System Interface	Pin	Packages
SCH4304	Super I/O controller, X-Bus interface, RTC and auto fan control over SensorBus™ sensor interface	FDC, parallel, 2 serial, 8042 KB controller, SMBus, 3 PWMs, 8 tachs, 51 GPIOs	LPC	128	QFP

PC SYSTEM & I/O CONTROLLERS: Embedded I/O Products

Highly-Integrated Super I/O Devices with Long Product Lifecycles for Embedded PC Platforms

Product	Features	I/O Ports	System Interface	Pin	Packages
SCH3112	Super I/O controller with SMBus hardware and voltage monitoring	2 serial, parallel, FDC, 8042 KB controller, 40 GPIOs	LPC	128	VTQFP
SCH3114	Super I/O controller with SMBus hardware and voltage monitoring	4 serial, parallel, FDC, 8042 KB controller, 40 GPIOs	LPC	128	VTQFP
SCH3116	Super I/O controller with SMBus hardware and voltage monitoring	6 serial, parallel, FDC, 8042 KB controller, 40 GPIOs	LPC	128	VTQFP
LPC47M10X	Super I/O controller, full legacy I/O support	2 serial ports, parallel, 8042 KB controller, FDC, 37 GPIOs	LPC	100	QFP
SIO10N268	Super I/O controller for ISA or LPC designs, X-Bus interface for I/O memory and FWH emulation	4 serial ports, parallel, FDC, WDT, 33 GPIOs	LPC/ISA	128	VTQFP
FDC37B78X	Super I/O controller, real-time clock, consumer IR, watchdog timer, 5V operation	2 serial ports, parallel, FDC, 8042 KB controller, parallel IRQs, serial IRQs, 20 GPIOs	ISA	128	QFP

CAPACITIVE TOUCH SENSORS							
Product	Input Channels	LED Drivers	Additional Features	Proximity Included	Interface	Pin	Packages
CAP1114	14	11	Slider, reset and alert, automatic recalibration, base capacitance compensation	✓	I ² C™/SMBus	32	QFN
CAP1188	8	8	Reset, wake and alert, automatic recalibration, base capacitance compensation	✓	I ² C/SPI/SMSC BC-Link™	24	QFN
CAP1128	8	2	Reset, wake and alert, automatic recalibration, base capacitance compensation	✓	I ² C/SPI/SMSC BC-Link	20	QFN
CAP1166	6	6	Reset, wake and alert, automatic recalibration, base capacitance compensation	✓	I ² C/SPI/SMSC BC-Link	20	QFN
CAP1126	6	2	Reset, wake and alert, automatic recalibration, base capacitance compensation	✓	I ² C/SPI/SMSC BC-Link	16	QFN
CAP1133	3	3	Alert, automatic recalibration, base capacitance compensation	✓	I ² C/SMBus	10	DFN
CAP1106	6	0	Alert, automatic recalibration, base capacitance compensation	✓	I ² C/SMSC BC-Link	10	DFN
CAP1105	5	0	Automatic recalibration, base capacitance compensation	✓	SPI	10	DFN
CAP1214	14	11	Slider, reset and alert, automatic recalibration, base capacitance compensation, audio output	✓	I ² C/SMBus	32	QFN

WIRELESS AUDIO: Highly Integrated Wireless Audio Baseband Processors

Product	Additional Features	Frequency	Interface	Pin	Packages
DARR82	Supports streaming of four wireless uncompressed stereo audio channels simultaneously or complete wireless 7.1 channel surround sound system, latency < 20 ms, point-to-multi-point transmission in home audio networking, SD and HD audio, excellent Wi-Fi® and Bluetooth® coexistence, bi-directional audio support, control data channel up to 100 kbps, integrated MCU and SRC	Dual-band 2.4/5.8GHz	I ² S, S/PDIF, I ² C™, SPI	80	LQFP
DARR83	Supports streaming of four wireless uncompressed stereo audio channels simultaneously or complete wireless 7.1 channel surround sound system, latency < 20 ms, point-to-multi-point transmission in home audio networking, SD and HD audio, excellent Wi-Fi and Bluetooth coexistence, bi-directional audio support, control data channel up to 100 kbps, integrated MCU and SRC, integrated audio class USB	Tri-band 2.4/5.2/5.8GHz	I ² S, S/PDIF, I ² C, SPI, USB 2.0	129	FBGA
DARR84	Supports streaming of two wireless uncompressed stereo audio channels simultaneously, supports a microphone input for voice applications, latency < 20 ms, point-to-multi-point transmission, SD and HD audio, excellent Wi-Fi and Bluetooth coexistence using Wireless DNA™ technology, control data channel up to 100 kbps, integrated MCU and SRC, integrated codec and headphone amplifier for headset applications	Tri-band 2.4/5.2/5.8GHz	I ² S, S/PDIF, I ² C, SPI/Analog In	129	FBGA
DM870A	Networked media processor, highly-flexible interface processor well-suited for secure, real time encoding/decoding and processing of multi-channel media content, offering industry standard networking and I/O interfaces, enables rapid product development by OEMs and ODMs, API structure on the software packages allows for easy product customization resulting in a faster time to market.	2.4GHz, 802.11 b/g	I ² S, S/PDIF, I ² C, USB, SD/SDIO, Ethernet, TFT for Display, SPI, CCIR 656 out	320	LFBGA
DM875	Reduced feature set version of the DM870A with no LCD and video output capability, well-suited for customer applications that support standard software AirPlay® software package	2.4GHz, 802.11 b/g	I ² S, S/PDIF, I ² C, USB, SD/SDIO, Ethernet, SPI,	320	LFBGA
DM860A	Available as an alternative to DM870A with no Wi-Fi capability.	-	I ² S, S/PDIF, I ² C, USB, SD/SDIO, Ethernet, TFT for Display, SPI, CCIR 656 out	320	LFBGA

WIRELESS AUDIO: Reference Designs

Product	Features	Frequency	Interface	Pin	Module Dimensions
DWAM82	Uncompressed wireless digital audio transceiver OEM modules based on the DARR82 and DARR83 chipsets, supports up to four stereo audio streams, data encryption, bi-directional control messaging, automatic pairing, WLAN detection, automatic frequency allocation	Single-band, 5.8 GHz	I ² S, S/PDIF, I ² C™, SPI	26-pin FFC Connector	42 x 42 mm Square PCB
DWAM83	Uncompressed wireless digital audio transceiver OEM modules based on the DARR82 and DARR83 chipsets, supports up to four stereo audio streams, data encryption, bi-directional control messaging, automatic pairing, WLAN detection, automatic frequency allocation	Tri-band, 2.4/5.2/5.8 GHz	I ² S, S/PDIF, I ² C, SPI	26-pin FFC Connector	35 x 35 mm Square PCB
DWUSB83	Uncompressed wireless digital audio transceiver OEM modules based on the DARR82 and DARR83 chipsets, supports up to four stereo audio streams, data encryption, bi-directional control messaging, automatic pairing, WLAN detection, automatic frequency allocation	Tri-band, 2.4/5.2/5.8 GHz	USB	-	49 x 18 mm
DWPcie83	Uncompressed wireless digital audio transceiver OEM module based on the DARR82 chip, supports up to two stereo audio streams, data encryption, bi-directional control messaging, automatic pairing, WLAN detection, automatic frequency allocation, well-suited for receiver applications such as speakers	Tri-band, 2.4/5.2/5.8 GHz	USB	-	30 x 26.8 mm
LCOS82	Uncompressed wireless digital audio transceiver OEM module based on the DARR82 chip, supports up to two stereo audio streams, data encryption, bi-directional control messaging, automatic pairing, WLAN detection, automatic frequency allocation, well-suited for receiver applications such as speakers	Single-band, 2.4 GHz	I ² S, S/PDIF, I ² C, SPI	26-pin Pin Header Connector	30 x 50 mm Rectangle

WIRELESS AUDIO: Highly-Integrated Wireless Audio Modules

Product	Features	Frequency	Interface	Pin	Module Dimensions
DWHS84	Uncompressed wireless digital audio ready-to-go headset and headphone application reference design that supports audio and microphone inputs to process gaming and VOIP headsets/headphone applications, supports multiple RF bands making it well-suited to effectively manage the interference commonly associated with Wi-Fi®, Bluetooth® and microwave ovens, using our Wireless DNA™ architecture, integrates 1MB SPI Flash, enabling KleerNet™ interoperability platform which allows for connectivity across products and brands	Tri-band 2.4/5.2/5.8 GHz	I²S, S/PDIF, I²C™, SPI	-	54 x 54.5 mm
DWL84	Uncompressed wireless digital audio transceiver OEM module based on the DARR84 chip, supports up to two stereo audio streams, data encryption, bi-directional control messaging, automatic pairing, WLAN detection, excellent Wi-Fi and Bluetooth coexistence using Wireless DNA architecture, well-suited for applications such as speakers and soundbars with subwoofers	Tri-band 2.4/5.2/5.8 GHz	I²S, S/PDIF, I²C, SPI	-	30 x 42 mm
CX870	Single-board, networked, media player module based on the DM870A media processors, enables fast product developments with Ethernet, USB and Wi-Fi connectivity, connects to standard legacy components in various audio, video/LCD and control formats.	2.4GHz, 802.11 b/g	I²S, S/PDIF, I²C, USB, SD/SDIO, Ethernet, TFT for Display, SPI, CCR 656 out	64-pin PCB Low Density Connector	46 x 85.8 mm

WIRELESS AUDIO: Radio Frequency Digital Audio Transceivers

Product	Features	Typical Sink Mode Power Consumption	PA Output Power	Audio	Qualification
KLR3012	Wirelessly streams uncompressed lossless audio up to 25m over robust 2.4 GHz radio link, multi-point to multi-point connectivity, strong WiFi® coexistence, data channel for audio playback control, very low power consumption	20 mW	1.5 dBm	16 bit, 44.1 Ks/s stereo	JEDEC

SECURITY

Product	Description	Processor Interface	# of Downstream Ports	Card Formats	Industrial Version	Package
SEC11X0	Smart Card Controller	USB 2.0	-	-	-	16-pin QFN
SEC120X	Smart Card Controller with Multi-Interface Support	USB 2.0	-	-	-	24- or 48-pin QFN
SEC2410	Smart Card Flash Media Controller with AES Encryption	USB 2.0	-	SD x2/MMC	✓	64- or 72-pin QFN
SEC4410	Smart Card Flash Media Controller with AES Encryption	HSIC	-	SD x2/MMC	✓	64- or 72-pin QFN

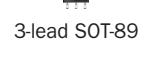
TERMS AND DEFINITIONS

1 KB	1024 bytes
1 Kw	1024 words
18F/PIC18	16-bit instruction word: 75/83 instructions
ADC	Analog to Digital Converter
AUSART	Addressable Universal Synchronous Asynchronous Receiver Transceiver
BL/Baseline	12-bit instruction word: 33 instructions
BOR/PBOR	Brown Out Reset/Programmable Brown Out Reset
CAN	Controller Area Network
CCP/ECCP	Capture Compare PWM/Enhanced Capture Compare PWM
CLC	Configurable Logic Cell
COG	Complementary Output Generator
Comp	Capacitive Sensing implemented via Comparator
CRC	Cyclical Redundancy Check
CSM	mTouch: Capacitive Sensing Module
CSP	Chip Scale Package
CTMU	mTouch™: Charge Time Measurement Unit
CVD	Charge Voltage Divide (Capacitive Sensing Implemented via ADC)
CWG	Complementary Waveform Generator
DAC	Digital-to-Analog Converter
DSM	Data Signal Modulator
dsPIC®	16-bit Core with DSP
EBL	Enhanced Baseline

EEPROM	Electrically Erasable Programmable Read Only Memory
EFT	Electrical Fast Transient
EMC	Electromagnetic Compatibility
EMI	Electromagnetic Interference
EMF/Enhanced Mid-Range	14-bit instruction word: 49 instructions (denoted as PIC1XF1XXX)
ESD	Electrostatic Discharge
EUSART	Enhanced Universal Synchronous Asynchronous Receiver Transceiver
EWDT/WDT	Extended Watch Dog Timer/Watch Dog Timer
HV	High Voltage
ICD	In-Circuit Debug
ICE	In-Circuit Emulation
ICSP™	In-Circuit Serial Programming™
IDE	Integrated Development Environment
Inst Amp	Instrumentation Amplifier
LCD	Liquid Crystal Display
LDO	Low Drop-Out voltage regulator
LF	Low Power Flash
MII/C/I²C™	Master Inter-Integrated Circuit bus/Inter-Integrated Circuit bus
MIPS	Million Instructions Per Second
MR/Mid-Range	14-bit instruction word: 35 instructions
MSSP/SSP	Master/Synchronous Serial Port (I²C & SPI Peripheral)
mTouch	Proprietary Touch Sensing Technology

NCO	Numerically Controlled Oscillator
Op Amp	Operational Amplifier
PIC10/12/16/18	8-bit Core
PIC24	16-bit Core
PIC32	32-bit Core
PLVD	Programmable Low Voltage Detect
POR/POOR	Power ON Reset/Power ON/OFF Reset
PSMC	Programmable Switch Mode Controller (16-bit PWM)
PWM	Pulse Width Modulation
RAM	Random Access Memory
RTCC	Real-Time Clock Calendar
SMT	24-bit Signal Measurement Timer
Source/Sink Current	All Products Support 25 mA per I/O
SR Latch	Set Reset Latch
SRAM	Static Random Access Memory
SPI	Serial Peripheral Interface
T1G	Timer 1 Gate
USART	Universal Synchronous Asynchronous Receiver Transceiver
USB	Universal Serial Bus
USB (Full Speed)	12 Mb/s Data Rate
USB OTG	USB On-The-Go
WWDT	Window Watch Dog Timer
XLP	nanoWatt XLP eXtreme Low Power Technology
ZCD	Zero Cross Detection

Product Packages

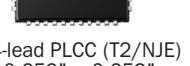
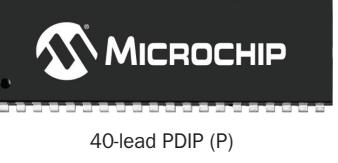
Small Outline	Dual Flat No Lead DFN	Quad Flat No Lead QFN	Plastic Shrink Small Outline SSOP	Plastic Small Outline SOIC
Bumped Die (WLCSP)		 8-lead DFN (MC) 2 x 3 x 0.9 mm	 16-lead QFN (MG) 3 x 3 x 0.9 mm	 8-lead MSOP (MS)
Die/Wafer (WLCSP)		 8-lead TDFN (MN) 2 x 3 x 0.75 mm	 20-lead QFN (ML) 4 x 4 x 0.9 mm	 8-lead SOIC (SN)
3-lead SC70 (LB)		 8-lead UDFN (MU) 2 x 3 x 0.5 mm	 20-lead QFN (MQ) 5 x 5 x 0.9 mm	 8-lead SOIC (SM)
5-lead SC70 (LT)		 8-lead DFN (MF) 3 x 3 x 0.9 mm	 28-lead UQFN (MV) 4 x 4 x 0.5 mm	 10-lead MSOP (UN)
3-lead SOT-23 (TT/CB)		 8-lead DFN (MD) 4 x 4 x 0.9 mm	 28-lead QFN (MQ) 5 x 5 x 0.9 mm	 16-lead QSOP (QR)
5-lead SOT-23 (OT)		 8-lead DFN (MF) 6 x 5 x 0.9 mm	 28-lead QFN (MM & ML) 6 x 6 x 0.9 mm	 20-lead SSOP (SS)
6-lead SOT-23 (OT/CH)		 Very Thin Thermal Leadless Array VTLA	 40-lead UQFN (MV) 5 x 5 x 0.5 mm	 28-lead SSOP (SS)
3-SOT-223 (DB)		 36-lead VTLA (TL) 5 x 5 x 0.9 mm	 8-lead TSSOP (ST)	 18-lead SOIC (SO)
4-lead SOT-143 (RC)		 44-lead VTLA (TL) 6 x 6 x 0.9 mm	 14-lead TSSOP (ST)	 20-lead SOIC (SO)
		 124-lead VTLA (TL) 9 x 9 x 0.9 mm	 20-lead TSSOP (ST)	 28-lead SOIC (SO)
Plastic Thin Shrink Small Outline TSSOP				

Packages are shown approximate size.

Additional packages are available: contact your local Microchip sales office for information.

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Product Packages

Plastic Thin Quad Flatpack TQFP	Plastic Quad Flatpack QFP	Plastic Dual In-Line PDIP	Additional Package Options	
 44-lead TQFP (PT) 10 × 10 × 1 mm	 80-lead TQFP (PF) 14 × 14 × 1 mm	 32-lead LQFP (LQ) 7 × 7 × 1.4 mm	 8-lead PDIP (P)	 NOR Flash Memory
 64-lead TQFP (PT) 10 × 10 × 1 mm	 100-lead TQFP (PT) 12 × 12 × 1 mm	 44-lead MQFP (PQ) 10 × 10 × 2 mm	 14-lead PDIP (P)	 RF Devices
 64-lead TQFP (PF) 14 × 14 × 1 mm	 100-lead TQFP (PF) 14 × 14 × 1 mm	 144-lead LQFP (PL) 20 × 20 × 1.4 mm	 18-lead PDIP (P)	 6-lead XSON (QX/QX6E) 1.5 × 1.5 × 0.5 mm
 80-lead TQFP (PT) 12 × 12 × 1 mm	 144-lead TQFP (PH) 16 × 16 × 1 mm		 20-lead PDIP (P)	 8-lead WSON (A6/QAE) 5 × 6 mm
Ball Grid Array BGA			 24-lead PDIP (P)	 32-lead PLCC (PE/NHE) 0.452" × 0.552"
		 100-ball BGA (BG) 10 × 10 × 1.1 mm	 28-lead SPDIP (SP)	 40-lead TSOP (W8/EIE) 10 × 20 mm
		 121-ball BGA (BG) 10 × 10 × 0.8 mm	 48-lead WFBGA (3T/MAQE) 4 × 6 × 0.73 mm	 8051-based Microcontrollers
			 48-lead TFBGA (8T/B3KE) 6 × 8 × 1.2 mm	 44-lead PLCC (T2/NJE) 0.652" × 0.652"
			 40-lead PDIP (P)	 48-lead TSOP (W9/EKE) 12 × 20 × 1.2 mm

Packages are shown approximate size.

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